The Aberration Corrected JEOL JEM-2200FS FEG-STEM/TEM Fitted with an Ω E Energy-Filter: Performance Characterization and Selected Applications

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A newly developed JEM-2200FS scanning transmission electron microscope (STEM) / transmission electron microscope (TEM) integrated with a CEOS aberration-corrector and an in-column Ω-energy-filter has recently been installed at Lehigh University. For this instrument, all the microscope parameters, including room environment, have been optimized in order to achieve the best resolution in a STEM imaging mode while simultaneously allowing efficient analytical capabilities by electron-energy-loss spectrometry (EELS). The STEM and TEM performances of the Lehigh JEM-2200FS are presented in this report as well as some initial results of atomic-column STEM-EELS analysis obtained from a Ni-base intermetallic alloy.

Introduction

The identification and quantification of the nature of individual atomic configurations are among the ultimate goals for the characterization of nano-structured materials. It is now possible to perform such advanced characterization in a scanning transmission electron microscope (STEM) equipped with a recently developed aberration corrector using electron energy-loss spectrometry (EELS) and X-ray energy dispersive spectrometry (XEDS). The primary improvement due to the aberration corrector is a significant reduction of the effects of spherical aberration, which has been one of the major limiting factors of electron lenses since the original development of transmission electron microscopes (TEMs). By employing aberration correction, the contrast delocalization effect can be significantly minimized for atomic-resolution phase-contrast imaging in static-beam TEM applications [e.g., 1, 2]. In addition, the STEM aberration-corrector can refine the incident probe dimensions significantly. In aberration-corrected STEMs, the resolution in high-angle annular dark-field (HAADF) imaging can reach sub Ångstrom levels [3] and materials characterization at the atomic level can routinely be performed by EELS [4]. Additionally, it has also recently been demonstrated that both the spatial resolution and the analytical sensitivity of XEDS analysis can be significantly improved by a use of the aberration-corrected 300 keV dedicated STEM at Lehigh, which is optimized for XEDS analysis [5].

Recently, a state-of-the-art JEOL JEM-2200FS 200 keV STEM/TEM integrated with a CEOS aberration corrector and an in-column Ω-energy-filter was installed at Lehigh. This instrument has been set up primarily to perform atomic-resolution HAADF-STEM imaging and simultaneous EELS analysis. In this report, the relevant microscope configurations are briefly described as well as the room modifications required to perform atomic-resolution characterizations on a routine basis. Then, the optimum probe forming parameters required to achieve atomic-scale characterization are theoretically discussed based on detailed probe simulations for the aberration-corrected STEM. Finally, the microscope performances both in the aberration-corrected STEM mode and in the TEM mode obtained in this instrument are demonstrated through some materials characterization studies.

The Microscope Configuration

Figure 1 shows the JEM-2200FS 200 keV STEM/TEM installed at Lehigh University. This instrument is equipped with a Schottky...
field-emission gun (FEG) source and an in-column Ω-type electron energy-filter. In addition to the regular TEM functions such as bright/dark-field imaging, electron-diffraction analysis and atomic-resolution phase-contrast imaging, the Ω filter allows acquisition of zero-loss (fully elastic) images and elemental distributions in thin specimens using inelastically scattered electrons. In the previous JEOL Ω-filter microscopes, the illuminated area is significantly shrunk and distorted as the accelerating voltage is increased, which is required to acquire energy-filtering elemental maps. This change in the illuminated area is due to the strong pre-field above the specimen, which in combination with the change in the accelerating voltage made energy-filtering work more difficult. In the JEM-2200FS, however, the illuminated area in the energy-filtering TEM mode remains the same at any energy-loss region as a function of illumination compensation. In practical energy-filtering work, this illumination compensation feature is found to be a highly desirable and effective modification. Furthermore, this instrument is also equipped with a CEOS Cs-corrector in the illumination system (above the objective lens) for probe refinement.

In addition to these major distinct features, many upgrades have been made from previous JEOL Ω-filter instruments. The post-specimen column lens configuration have been modified so as to have as 4 and 2 post-specimen lenses at the pre- and post-Ω-filter positions, respectively. The additional post-specimen lens at the pre-Ω-filter position inhibits any image or defraction-pattern rotation as the magnification or camera length is changed. There is also a HAADF detector above the Ω filter, which makes STEM-EELS acquisition possible in combination with the additional post-specimen lens. This microscope is also equipped with another bright-field (BF) and ADF detectors positioned after all the lenses. In addition to the EELS functions facilitated by the Ω-filter, a ThermoElectron XEDS detector having a collection angle of 0.13 sr is also fitted to this microscope.

Microscope stabilities have also been improved. The specimen holder (which may be the most sensitive to influence by the external environment) is completely isolated by an o-ring sealed “clam shell” after loading into the microscope column. Due to the clam shell, stage drift is significantly reduced. The JEM-2200FS microscope is equipped with active suspensions at the four corners of the instrument base, which act to efficiently reduce high frequency vibrations.

The whole microscope is operated through different 5 computers (namely for (i) the major controls, (ii) STEM operation, (iii) image/EELS acquisition, (iv) XEDS acquisition and (v) aberration correction), which are linked via a local area network. Because all the controls, including apertures and energy-selection slit, can be accessed digitally, the instrument can also be operated remotely with the JEOL Sirius interface. For instance, the microscope has been operated remotely via a regular internet line from NASA Goddard, MD, USA, which is located ~280 km away from Lehigh University.

The Room Construction

To achieve 1 Å or sub-Å resolution in STEM imaging and analysis, the local environment surrounding the microscope needs to be carefully controlled. The key environmental factors that influence microscope performance can be summarized as: (i) stray electromagnetic fields, (ii) air flow, (iii) sudden air pressure changes, (iv) temperature drift and (v) residual noise (e.g. caused by fans in power supply units and computers). Some of these factors are strongly correlated with one another, and hence minimizing these environmental issues are essential requirement for advanced microscopy performance at atomic-column resolution levels. The microscope room for the JEM-2200FS at Lehigh has been modified from its previous configuration based largely on practical suggestions described by Muller and Grazul [6].

In order to reduce the electromagnetic fields, all metal parts such as ceiling grids, pipes, HEPA filters and duct work as well as metal raceways for wiring were removed. The major power supply units for the microscope were isolated in a separate air-conditioned room. All fluorescent lights were replaced with high intensity fluorescent bulbs and discrete sockets were installed for accessory power.

For the reduction of instabilities arising from air flow and air pressure changes, air conditioning filters and ducts were removed and a low-flow duct soc was installed on one of the walls at a distance of more than 3 m from the microscope column. In addition, an air-lock double door was installed and the microscope column has been surrounded with a curtain. The room temperature is controlled by 26 cooling panels mounted on the walls and ceiling as shown in Fig. 1. Since water circulated by a conventional chiller is used as coolant for the panels, no direct air flow is created for cooling unlike regular air conditioning. Using the cooling panels, the room temperature can be kept constant at 21°C with a temperature fluctuation of -0.2°C per hour.

For acoustic noise reduction, water chillers and vacuum pumps were positioned outside of the microscope room and acoustic baffles were installed between the cooling panels and ceiling/side walls as well as at each corner in the

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**Fig. 1** An image of the JEM-2200FS STEM/TEM at Lehigh University. Installed acoustic baffles and water-cooling panels can also be seen on the ceiling and side walls in the microscope room.

**Fig. 2** A screen shot of the CEOS aberration-correction software after Zemlin tableau auto-tuning. The measured aberration coefficients and phase shift image calculated from the tuned results are also displayed.
room. In Fig. 1, the cooling panels and the acoustic baffles can be clearly seen. Furthermore, fan silencers were mounted on selected power supply units and computers to reduce noise.

**Characterization of Aberration-Corrected STEM Performance**

**CEOS aberration-correction system**

The CEOS aberration-corrector for the illumination system is positioned in the column between the condenser and objective lenses as shown in Fig. 1. The corrector consists of 2 hexapoles and 2 pairs of transfer lens couples, which can be tuned automatically using the Zemlin tableau method for probe shape analysis. This method involves measuring a series of probe shapes as a function of the tilt angle based on the deconvolution technique between focused and over-/under-focused ADF images [7, 8]. After auto-tuning using the tableau technique, a series of probe shapes at different tilt angles is displayed with the phase shift image being calculated from the measured aberration coefficients up to 5th order (Fig. 2). Typical values of the measured aberration coefficients after auto-tuning are also summarized in Table 1. Since the JEM-2200FS at Lehigh is equipped with an ultra high resolution pole-piece, the original values of the spherical ($C_1$) and chromatic ($C_s$) aberration coefficients, which are the smallest obtainable in current available 200 keV instruments, are shown in Table 1 for comparison. After aberration correction, the $C_1$ value is significantly reduced to ~3.8 µm (1/120 of the original value!) with a 5th-order aberration coefficient ($C_5$) of only 3.2 mm. Note that the $C_1$ value in the corrected condition is slightly enlarged from the original value due to the presence of the aberration corrector. However, this enlargement in $C_1$ has only a marginal effect on the fine probe formation in a 200 keV FEG instrument.

After the auto-tuning process, lower order aberrations such as the twofold astigmatism ($A_1$) and 2nd-order axial coma ($B_1$) can be adjusted manually by observing the Ronchigrams (i.e. the defocused shadow image). Figure 3 shows comparisons of the Ronchigrams obtained from Au nano particles on a thin Ge support film in the hexapole-off (a) and on (b) (i.e. aberration corrected) modes. It should be mentioned that the correction can be defeated by turning the hexapoles off even after corrector tuning. In both Ronchigrams, the intensity distribution becomes uniform at the center. It is usually considered that the lens aberrations no longer influence the incident probe formation within the region of uniform intensity within the Ronchigram. In the uncorrected mode with $C_1 = 0.5$ mm, the uniform intensity area in Fig. 3(a) is only 11 mrad wide, and hence a smaller probe-forming aperture (which also limits the available probe current) must be used to avoid the influence of spherical aberration. Conversely, the uniform intensity region in the Ronchigram is expanded to over 34 mrad after corrector auto-tuning followed by the manual adjustments of $A_1$ and $B_1$, as shown in Fig. 3(b). The expansion of the uniform intensity area means that a larger probe-form-

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Table 1: Summary of aberration coefficients of the JEM-2200FS for (a) conventional and (b) typical aberration-corrected conditions.

<table>
<thead>
<tr>
<th>Condition</th>
<th>Spherical Aberration, $C_1$</th>
<th>Chromatic Aberration, $C_s$</th>
</tr>
</thead>
<tbody>
<tr>
<td>(a) conventional condition</td>
<td>$C_1 = 0.5$ mm</td>
<td>$C_s = 1.1$ mm</td>
</tr>
<tr>
<td>(b) aberration-corrected condition</td>
<td>$C_1 = 0.5$ mm</td>
<td>$C_s = 1.1$ mm</td>
</tr>
</tbody>
</table>

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<thead>
<tr>
<th>Twofold astigmatism, $A_1$</th>
<th>$5.8$ nm</th>
<th>$A_1 = 12$ µm</th>
</tr>
</thead>
<tbody>
<tr>
<td>2nd-order axial coma, $B_1$</td>
<td>$40$ nm</td>
<td>$B_1 = 25$ µm</td>
</tr>
<tr>
<td>Threefold astigmatism, $A_3$</td>
<td>$94$ nm</td>
<td>$A_3 = 25$ µm</td>
</tr>
<tr>
<td>3rd-order spherical aberration, $C_3$</td>
<td>$3.8$ µm</td>
<td>$C_3 = 3.2$ mm</td>
</tr>
<tr>
<td>3rd-order star aberration, $S_1$</td>
<td>$390$ nm</td>
<td>$S_1 = 3.2$ mm</td>
</tr>
<tr>
<td>Fourfold astigmatism, $A_4$</td>
<td>$226$ nm</td>
<td>$A_4 = 226$ nm</td>
</tr>
<tr>
<td>4th-order axial coma, $B_3$</td>
<td>$12$ µm</td>
<td>$B_3 = 25$ µm</td>
</tr>
</tbody>
</table>

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Fig. 3 Ronchigrams (defocused shadow images) recorded from a specimen of Au nano-particles on a Ge film at nearly focused conditions in the JEM-2200FS: (a) uncorrected mode with hexapole-off and (b) corrected mode with hexapole-on. The twofold astigmatism and 2nd-order axial coma were manually aligned.

Fig. 4 (a) The probe diameters containing 50% of the total intensity simulated based on the polychromatic point source for the conventional (open triangle) and aberration corrected (full aberrations: open circles, main aberrations only: closed circles) JEM-2200FS, plotted as a function of the convergence semi-angle. (b) The overall probe diameters containing 50% and 90% of the total intensity simulated by convolving the polychromatic intensity distribution with the Gaussian intensity distribution, plotted against the probe current. The polychromatic intensity distributions at $\alpha = 12$ and 25 mrad were used for the conventional (open & closed triangles) and aberration-corrected (open & closed circles) conditions, respectively.

Fig. 8 (a) An HAADF-STEM image of an L12-type γ precipitate along <100> in the Ni-base superalloy X-750. This image is slightly distorted due to some instabilities during acquisition. (b) Intensity profiles extracted from atomic layers containing only face-centered atoms (A site) and both face-centered and corner atoms (A & B sites). (c) EELS spectra around the Ti L2,3 edge measured from the A- and B-sites, respectively. (See the next page.)
ing aperture can be used without suffering any influence of lens aberration. Therefore, the use of aberration correction for probe refinement can provide not only improved resolution in HAADF imaging, but also actual benefits for analysis via X-rays or energy-loss electrons due to the significantly increased probe currents (5-10×).

Theoretical evaluation of probe dimensions in aberration-corrected STEM

Both imaging and analytical performance in STEM (as exemplified by resolution and analytical sensitivity) are directly influenced by the incident probe dimensions (i.e., sizes and intensity distributions). The finest probe with the highest current is always preferable to achieve the best imaging and analytical performance. In order to perform STEM imaging and analysis with the highest possible resolution and sensitivities, it is essential to estimate the optimized probe forming conditions and the probe dimensions for appropriate applications. Since the uniform intensity area in the Ronchigram is expanded by the STEM aberration-correction as shown in Fig. 3, the optimized conditions in the aberration-corrected mode are very different from those encountered in the conventional situation. In general, the complete probe simulation can be performed via three steps: (i) calculation of the intensity distribution from a monochromatic point source that contains only geometrical aberrations and defocus, (ii) calculation of the intensity distribution from a polychromatic point source including chromatic aberration by adding a series of monochromatic intensity distributions with certain weights based on the electron energy spread function of the gun and (iii) calculation of the intensity distribution from an overall extended source by convolving the polychromatic distribution with the contribution of the probe current. The details of the probe simulation are summarized by Colliex and Mory [9]. In this study, the intensity distributions from the monochromatic and polychromatic point sources were simulated by following an approach described by Haider et al. [10].

Figure 4(a) shows probe diameters of the polychromatic intensity distributions containing 50% of the total intensity (which is usually considered as a suitable size for HAADF image resolution) in the conventional and aberration-corrected conditions of the JEM-2200FS, plotted as a function of the convergence semi-angle (α). For this simulation, the aberration coefficients summarized in Table 1 were used with the source energy spread of 1.0 eV. It should be noted that the probe diameters in the aberration-corrected conditions were simulated with only major aberration coefficients of C_s, C_5 and C_c (closed circles) and with full aberration coefficients up to 5th-order except for A_1 and B_2 (open circles). Hence, it can be considered that the probe diameters simulated using only the major aberrations are ideal limits in this particular aberration-corrected condition. In the conventional condition, the probe diameter becomes a minimum (optimum) at α = 11-12 mrad, which is consistent with the angular range of uniform intensity in the Ronchigram as shown in Fig. 3(a). In contrast, the probe diameter in the
aberration-corrected conditions becomes a minimum at $\alpha = 20-26$ mrad, which is higher than the optimum $\alpha$ in the conventional condition. However, as an estimation of the optimum beam size, the aberration-corrected condition is still smaller than the angle measured from the uniform intensity area ($>34$ mrad) in the Ronchigram shown in Fig. 3(b). The difference in the optimum angle between the simulated probe diameter and the experimentally obtained Ronchigram suggests that the uniform intensity area size may not simply be used as an estimator of the optimum beam size, especially in the aberration-corrected condition. Further discussion concerning the optimum condition for TEM will be published elsewhere [11].

The simulated probe diameters shown in Fig. 4(a) represent blurring of a point source due to the geometrical (monochromatic) and chromatic (polychromatic) aberrations. These probe diameters are useful to estimate the optimum conditions for obtaining ideal resolution of the HAADF-STEM imaging with limited probe currents. However, it is essential to take into account the contribution of the probe current in order to estimate spatial resolution for analysis via X-rays or electron energy-loss spectroscopy. A detailed study of this was carried out by Brown [12] and Watanabe et al. [5]. Because the contribution of the probe current can be described by assuming an initial Gaussian diameter at the electron gun, the overall probe distribution from the extended source can be calculated by a convolution of the polychromatic intensity distribution with the Gaussian image of the electron gun [9]. For simplicity, a Gaussian diameter of a brightness value of $2 \times 10^4$ Am$^2$sr was used for the Schottky FEG source [13]. The overall probe diameters simulated at the optimum $\alpha$ for the conventional and aberration-corrected conditions (12 and 25 mrad, respectively) are plotted against the probe current in Fig. 4(b). Probe diameters containing 90% of the total intensity (closed symbols) are also plotted in addition to the 50% diameters (open symbols) since the 90% diameter is a more relevant definition for chemical analysis [5, 14]. In the conventional condition, the probe current is usually limited to $\sim 10$ pA for atomic resolution HAADF-STEM imaging and the 50% and 90% probe diameters are $8.5$ and $12$ mrad, respectively (plotted in red in Fig. 4(b)). The simulated intensity distribution of the incident probe and a HAADF-STEM image of Si $<110>$ recorded in the conventional condition are shown in Figs. 5(a) and 6(a), respectively. The image is very noisy due to the limited probe current available, and the projected Si-Si dumbbell spacing of 1.36 Å could not be resolved. In the aberration-corrected condition, the probe current can be increased to over 100 pA to obtain the same 50% probe diameter (1.6 Å) as in the conventional condition. This $>10 \times$ higher current can improve the analytical sensitivity in XEDS and EELS experiments. On the other hand, the 50% diameter can be made smaller than 1.6 Å by using a probe current in the probe current range between 10-100 pA, which all the microscope parameters such as the gun emission and gun/column lens setting were carefully chosen in order to achieve improved resolution in HAADF-STEM imaging and to gather sufficient signals for EELS analysis. Conversely, the improvement of the incident electrons needed to be kept as good as possible since the energy resolution is usually degraded as the gun emission increases to generate higher probe currents. Therefore, it has been found that the current at which the probe beam becomes corrupted by the above conflicts is $\sim 50$ pA. According to the results of the probe simulation shown in red symbols in Fig. 4(b), the diameters containing 50 and 90% of the total intensity are 1.2 and 3.5 Å, respectively. Figures 5(b) and 6(b) show the simulated probe shape and a recorded HAADF-STEM image of Si $<110>$ with 50 pA in the aberration-corrected condition. The intensity profile of the corrected probe is about twice that in the conventional probe. This enhancement can provide a better signal-to-noise ratio in imaging. It is however important to note that the aberration-corrected probe has threefold tails instead of the ring-shape tail typical of a spherically aberrated probe (Fig. 5(a)). The threefold tails in the corrected probe are caused by the residual higher-order aberrations in the hexapole-based corrector. In comparison with the conventional image in Fig. 6(a), the ADF-STEM image of Si $<110>$ (Fig. 6(b)) is greatly improved with higher contrast and the 1.36 Å spacing is now successfully resolved. Figure 7 shows some EELS results obtained in this aberration-corrected STEM condition. Figure 7(a) presents the energy resolution in this particular condition determined by recording two zero-loss peaks separated with a 10-eV energy shift. Figure 7(b) shows an EELS spectrum in the vicinity of the Si K edge (1839 eV) for a 10-s acquisition. It is possible to measure such an EELS spectrum at higher core-loss regions with a reasonable acquisition time while still maintaining the atomic-scale resolution (1.36 Å) and a reasonable energy resolution ($\sim 1.1$ eV). Therefore, atomic-column characterization of materials can in practice be performed by EELS analysis in the aberration-corrected JEM-2200FS.

A demonstration of atomic-column characterization

Figure 8(a) shows an atomic-resolution HAADF-STEM image recorded from a $<100>$ projection of an L1$_2$-type $\gamma$ precipitate (Ni$_3$Al) in a Ni-base superalloy (X-750). In this particular projection of the precipitate, the atomic separation is resolved by examining the HAADF image. Furthermore, there are two distinctly different intensities displayed by the major atomic columns in the HAADF image. Intensity profiles extracted from an atomic layer containing only brighter atomic spots and from a layer with both brighter and darker columns in the HAADF image are shown in Fig. 8(b), respectively. The intensity of the darker columns are $\sim 1/3$ of that found in the brighter columns, which is indicative of the difference in average atomic number between the projected atomic columns. In comparison with the expected atomic configurations in the L1$_2$ structure, the brighter columns correspond to face-centered Ni (A site), whereas the less intense columns correspond to Al (B site) atom positions in the L1$_2$ structure.

According to XEDS analysis performed prior to the HAADF and EELS approaches, this $\gamma$ precipitate has a high Ti content (about twice that of Al in atomic fraction). Figure 8(c) shows two EELS spectra in the vicinity of the Ti L$_{2,3}$ edge ($\sim 450$ eV) recorded from the A and B sites, respectively. It is clear that the Ti L$_{2,3}$ edge intensity is more significant in the spectrum obtained from the B site. These results suggest that the Ti atoms preferentially occupy the B-site in the L1$_2$ structure by substituting for Al atoms, which agrees with previous studies using the X-ray based ALCHEMI method [e.g. 15]. Using the new generation aberration-corrected STEMs, therefore, such site occupancies of alloying elements or even impurity elements can be determined directly at the individual atomic-column level, not by averaging information from broad regions as is traditional for STEM analyses. Atomic-column-level characterization on the atomic-column-by-atomic-column scale can now, at least, be achieved in practice using state-of-the-art commercial STEMs equipped with aberration correctors. This atomic-column-point analysis capability implies not only detection, but also the characterization of a single atom impurity is feasible in aberration-corrected STEMs, when used in combination with the latest spectrum imaging and advanced statistical analysis techniques.

TEM Performance with an Activated STEM Corrector

In addition to the impressive STEM performance, the JEM-2200FS has all the TEM functionality as well, and it is designed so that both the TEM and aberration-corrected STEM modes can be seamlessly switched back and forth. TEM performance of this type has previously been reported for an instrument with a TEM aberration corrector [2, 8]. In the original TEM mode, the aberration corrector is deactivated. In the JEM-2200FS at Lehigh, however, the TEM mode has been set up while keeping the aberration corrector activated. This special TEM mode is called the CsSTEM mode and is very important for doing atomic resolution STEM work where one wishes to avoid any electronic instabilities caused by turning the STEM corrector on and off. Several TEM-resolution performance characteristics in the CsSTEM mode are summarized in Fig. 9. The point resolution as determined from Cu particle on a Ge thin-film using the optical diffraction method is 0.19 nm (Fig. 8(a)). The information limit measured from a poly-crystalline Ti thin-film by employing the Young’s fringe method was found to be 0.11 nm (Fig. 9(b)). Figures 9(c) and 9(d) show an atomic resolution phase contrast image from Si $<110>$ and its Fourier-transformed diffractogram, respectively. Although the 1.36-Å atomic spacing is not resolved in the phase contrast image, Bragg spots corresponding to [224], [115] and [333] with those in the original TEM mode, it can be concluded that the TEM performance of the JEM-2200FS is not degraded at all by the activation of the STEM corrector. Additionally, a static convergent probe can also be formed with STEM-corrector activation, which is called the CsCBD mode. In contrast to the CsSTEM mode, the aberration corrector is acti-
in this instrument are available even in the static probe mode in addition to the scanning probe mode.

In the static probe mode, materials can also be characterized by energy-filtering via the \(\Omega\) filter. Figure 10 shows a series of energy-filtered images taken from a cross-section Si/Si-Ge multilayer thin film, which is reported to be one of the most useful specimens for evaluating energy-filtered images [16]. Unfiltered (conventional) and zero-loss filtered bright-field (BF) images are shown in (a) and (b), respectively, and the relative thickness map determined from both the BF images is presented in (c). The elemental maps of Si L (d), Ge L (e) and Si K (f) ionization edges were obtained by the three-window method. These filtered images were recorded in the CsTEM mode. The elemental distributions using higher energy-loss edges such as the Ge L (1217 eV) and Si K (1839 eV) are very clear. This is a clear demonstration that the illumination compensation works very well at higher energy-loss regions.

Summary

The newly developed JEM-2200FS STEM/TEM has been successfully installed at Lehigh University. This instrument has been optimized for EELS analysis in the atomic-resolution HAADF-STEM imaging mode by the integration of the CEOS aberration-corrector for STEM and an in-column \(\Omega\)-filter, which provides significant improvements in the imaging and analytical performance. Characterization on the atomic column-by-atomic column scale can be achieved using the JEM-2200FS with the STEM aberration corrector. In addition to the STEM mode, static-beam TEM-based operations can also be performed without any degradation in atomic resolution phase-contrast imaging or energy filtering in the STEM-corrector activated mode.

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References

Applications of Aberration Corrected Transmission Electron Microscopy to Materials Science

Introduction

Richard Feynman is commonly associated with the nanoscience revolution as a result of his lecture “There’s Plenty of Room at the Bottom” given in 1959 [1]. Less well known, is his challenge, in the same lecture to “improve the resolution of the electron microscope by 100 times”. It has been long understood that the resolution of the electron microscope is limited by the intrinsic spherical aberration in the objective lens to values nearly two orders of magnitude poorer than the electron wavelength. This spherical aberration arises from the rotationally symmetric magnetic field of the objective lens and to correct this requires sophisticated electron-optical components which break the rotational symmetry [2]. The successful design and development of such correctors for transmission electron microscopes (Figure 1) has led to a rapid improvement in the interpretable resolution to sub 0.1 nm levels at intermediate voltages (Figure 2). The major reason that it has taken over four decades to achieve this is the requirement for sophisticated computer control to measure the aberrations present and to iteratively adjust the necessary lens currents. However, the current generation of correctors readily achieve this and are able to correct the electron wave front to a degree of perfection better than a quarter wavelength (~ 0.5 pm) over 70 microns, a level of performance that exceeds that of the Hubble Space Telescope.

There are presently two designs of aberration corrector available for electron microscopes produced by Nion [3] and by CEOS [4]. The former has been exclusively used in Scanning Transmission Electron Microscopy (STEM), whereas the latter has been used in both STEM and in conventional Transmission Electron Microscopy (TEM). Although the optical design of these two systems differs, it is important to appreciate that both correct only for the geometric aberrations (Figures 3 (a) and (b)) of the optical system through the use of non-round elements. Chromatic aberration (Figure 3 (c)) correctors which require electrostatic elements have so far only been successfully developed in the Scanning Electron Microscope (SEM) [5] which operates at significantly lower accelerating voltages.

Aberration correction in TEM images leads to both improvements in interpretable resolution and to reduced image delocalisation. In the absence of spherical aberration, to a first approximation, the point-to-point resolution in a high resolution image is extended out to the limits imposed by the partial temporal coherence of the illumination. Information delocalisation, arising from the presence of aberrations in an uncorrected microscope, is also substantially reduced with particular benefits to imaging of surfaces, boundaries and other aperiodic features.

Mention should also be made of indirect methods which deconvolve the effects of aberrations from a series of TEM images, to restore the complex wavefunction at the exit plane of the specimen [6]. These “off-line” procedures can be usefully applied not only to uncorrected TEMs but also to TEMs fitted with aberration correctors to remove the effects of residual aberrations and to compensate for higher order aberrations that cannot be corrected directly (see later).

Aberration Measurement and Correction

An essential component in the operation of aberration corrected instruments is the measurement of the objective lens aberrations. The relevant theories of wave optics applicable to HRTEM are well established and are detailed elsewhere [7, 8]. The aberration coefficients are conveniently defined in terms of a wave aberration function, \( W \), that measures the axial distance between the actual diffraction plane wavefront and the ideal spherical wavefront and importantly for HRTEM also describes the phase shift in a ray passing through the lens in a particular direction.

In polar form this can be written as a Taylor expansion (to third order) with (complex) aberration coefficients

\[
W(\theta, \phi) = \left| A_0 \right| \theta \cos(\phi - \phi_0) + \frac{1}{2} \left| A_1 \right| \theta^2 \cos 2(\phi - \phi_2) + \frac{1}{6} \left| A_2 \right| \theta^3 \cos 3(\phi - \phi_3) \\
+ \frac{1}{2} \left| B_1 \right| \theta^2 \cos(\phi - \phi_4) \\
+ \frac{1}{6} \left| B_2 \right| \theta^3 \cos 2(\phi - \phi_5) + \frac{1}{2} \left| C_1 \right| \theta^4 + \ldots \tag{1}
\]

which demonstrates the azimuthal and radial dependence of the various aberration terms.

The terms in \( C_1 \) and \( C_2 \) correspond to defocus and spherical aberration and are the only terms present in perfectly round lenses with the...
spherical aberration positive for electromagnetic lenses. In order to correct them it is necessary to introduce combinations of multipole fields of appropriate symmetry which forms the optical basis for aberration correction.

The aberration correctors used in the JEOL JEM-2200FS installed at Oxford [9] are based on a pair of strong electromagnetic hexapole elements together with four additional lenses [10] (Figure 4). Correction is achieved due to the fact that the primary second-order aberrations of the first hexapole (a strong three fold astigmatism) are exactly compensated by the second hexapole element. Owing to their non-linear diffraction power, the two hexapoles additionally induce a residual secondary, third-order spherical aberration which is rotationally symmetric with a negative sign, thus cancelling the positive spherical aberration of the objective lens. For HREM applications it is essential that the corrector is aplanatic to provide a sufficiently large field of view which can be achieved by matching the coma-free plane of the objective lens to that of the corrector using a round transfer-lens doublet. In addition to these primary optical elements the correctors also contain a number of additional weak multipole elements which are used for alignment and correction of any residual parasitic aberrations.

These phase shifts determined by the aberration coefficients of Equation 1 can be usefully used to estimate the maximum tolerable value in any coefficient for a particular target resolution as given in Table 1 which in turn reflects the required precision in their measurement. In particular Table 1 clearly indicates the twin requirements of both increased precision in the measurement of any given coefficient with increasing resolution and for the determination of an increased number of coefficients as the resolution is improved.

Practical operation of aberration correctors requires the accurate, local measurement of the aberration coefficients. Experimental determin-
nation of the majority of the axial aberration coefficients relies on the measurement of one of several possible observables as a function of known injected beam tilts. The most commonly used methods rely on the determination of either image shifts, or defocus and astigmatism for which a suitably conditioned set of known beam tilts provides a method for measuring all coefficients [8, 11, 12]. The advent of aberration-corrected instruments has made automated aberration measurement even more important because the non-round lens elements introduce a multitude of high-order aberrations (up to six-fold astigmatism) that require correction in an elaborate alignment procedure. For this purpose the current generation of TEM correctors rely on a robust and computationally efficient algorithm that evaluates the apparent defocus and astigmatism from a diffractogram in less than 400 ms based on a comparison of experimental diffractograms to a stored library of simulated diffractograms.

Applications to Materials Science

The first application described here is the characterisation of nanometer sized crystals of compound semiconductors which exhibit novel optical properties. Figure 5 shows aberration corrected images of nanometer sized CdSe crystallites in which the benefits of aberration correction are immediately evident. In the first instance the elimination of the spherical aberration leads to a significant reduction of image delocalisation at the particle surface, thus enabling a more accurate measurement of the particle shape in projection. In addition the restricted depth of field leads to a substantial reduction in contrast from the amorphous support film compared to uncorrected imaging, further increasing the visibility of the particle. In particular we note that both particles shown in Figure 5 exhibit stacking faults, dislocations and regions of both hexagonal and cubic stacking sequences despite their small size and this may have a direct influence on their optical properties.

Our second example application combines direct electron optical aberration correction with local aberration measurement [13] and subsequent exit wave restoration as summarised in Figure 6. For the experiment described here a focal series of aberration corrected images was initially used to recover the specimen exit wave using a Wiener restoring filter [6]. Subsequently local aberration coefficients from a subregion of interest were measured with an accuracy of <1 nm [11, 12] and these were used to refine the exit wave by application of an appropriate phase plate parameterised by the locally determined axial aberrations in Fourier space. Figure 7 illustrates the phase plates obtained after initial electron optical correction to third order and subsequently after refinement to fifth order together with the resultant exit wave function of a nanocrystalline Pt particle. It is apparent that whereas the initial phase plate shows significant variation at the 0.1 nm transfer limit set by the partial coherence of the microscope the refined phase plate is constant to a value beyond this limit. The restored phase of the particle shows a number of interesting structural features which are not immediately apparent in the individual images including

![Figure 4](image.png) Optical ray diagram for the hexapole based aberration corrector used in the Oxford — J EOL J EM-2200FS (reproduced from [10]).

![Figure 5](image.png) Aberration corrected images of nanometer sized CdSe particles (a) 5 nm crystallite showing hexagonal and cubic stacking regions (marked H and C respectively) and a (111) stacking fault marked F (b) 2 nm CdSe crystallite containing stacking faults marked with arrows.

Table 1 Precision required in the coefficients of the wave aberration function for various target resolutions (adapted from [10]).

<table>
<thead>
<tr>
<th>Coefficient</th>
<th>π/4 limit</th>
<th>π/4 limit at 200kV</th>
</tr>
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<tbody>
<tr>
<td></td>
<td>gmax = 4nm⁻¹</td>
<td>gmax = 7nm⁻¹</td>
</tr>
<tr>
<td>C₁</td>
<td>6.2nm</td>
<td>2.0nm</td>
</tr>
<tr>
<td>A₁</td>
<td>0.93µm</td>
<td>0.17µm</td>
</tr>
<tr>
<td>B₂</td>
<td>0.31µm</td>
<td>58nm</td>
</tr>
<tr>
<td>C₃</td>
<td>0.12µm</td>
<td>13µm</td>
</tr>
<tr>
<td>S₃</td>
<td>31µm</td>
<td>3.3µm</td>
</tr>
<tr>
<td>A₄</td>
<td>15mm</td>
<td>0.94mm</td>
</tr>
<tr>
<td>B₄</td>
<td>3.1mm</td>
<td>0.19mm</td>
</tr>
<tr>
<td>D₄</td>
<td>3.1mm</td>
<td>0.19mm</td>
</tr>
<tr>
<td>C₅</td>
<td>1.8mm</td>
<td>64nm</td>
</tr>
<tr>
<td>A₅</td>
<td>1.8mm</td>
<td>64nm</td>
</tr>
</tbody>
</table>
Direct C3 correction and focal series acquisition.

Initial corrector alignment.

3rd Order Correction

Refinement of C1, C3 and A1 from specific sample area.

Exit Wave Reconstruction (3rd Order).

5th order Compensation / refinement

Exit Wave Refinement (5th Order).

Measurement of Residual Higher Order Aberrations

Fig. 6 A schematic illustration of the steps involved in combined electron optical correction and exit wave reconstruction.

(a)

(b)

Fig. 7 (a) Phase plates prior to (left) and post (right) aberration refinement to 5th order. Inner and outer circles mark resolution limits of respectively 0.1 and 0.08 nm in both cases. (b) Restored exit plane wavefunction of a nanocrystalline platinum catalyst particle restored from an aberration corrected through focal series of images and subsequent aberration refinement as described in the text. Arrows mark local surface irregularities and the circle highlights localised support crystallinity.

stepped and partially occupied surfaces and local support crystallinity.

Conclusions and Future Directions

At the present time spherical aberration has been successfully corrected in TEM, improving the point resolution to the information limit. In order to extend the information limit itself there are two possibilities, both of which are actively being pursued. The first possibility is to reduce the energy spread of the electrons (and thus improve the limit set by temporal coherence) by replacing the standard thermally assisted Schottky FEG with a Cold FEG, or by monochromating the electron beam. The second is to correct the chromatic aberration of the objective lens [14] using a complex combination of magnetic and electrostatic multipole elements. An improved information limit will allow not only greater detail and precision to be obtained in the analysis of the atomic structure of materials but will also permit the use of large gap pole pieces without the constraint of minimising Cs and Cc. These larger gap lenses will in turn allow the use of a wider range specialised specimen holders for in-situ experiments and measurements with dynamic observation.

Acknowledgements

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References

Visualization of Biological Nano-Machines at Subnanometer Resolutions

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Introduction

Based on genome sequence analysis, it has been suggested that a living cell conducts 200-300 distinct biological processes (Martin and Drubin, 2003), each of which can be carried out by macromolecular complexes. These complexes, which can both be persistent and transitory, are usually relatively large (>0.5 MDa) and contain specific and complex spatial organization of components to facilitate their dynamic behaviors. As such, these complex assemblies actually are biological nano-machines. As the name implies, an analogy can be drawn to almost any conventional man-made machine in which the machine is composed of multiple components operating in a coordinated fashion to perform one or more biological functions. These biological nano-machines can be found throughout the cell, responsible for key processes such as cell division and signaling, as well as being critical in diseases such as cancer or viral infections.

Nano-machines are not restricted to “large-scale” cellular processes and may be involved in genome replication and repair, protein folding, protein trafficking and ion transport (Gavin et al., 2006; Krokan et al., 2006). These machines can assume different forms, shapes and symmetries. Therefore, knowledge of the molecular structures of the biological nano-machines, their components and their interactions can provide both mechanistic descriptions of function and clues for developing therapeutics related to health and disease. However, because of all these intrinsic complexities, structure elucidation of biological nano-machines at sufficient resolutions often poses a serious challenge.

Using Single Particle Cryo-EM to Study Nano-Machines

Electron cryo-microscopy (also known as cryo-electron microscopy or cryo-EM) is the most appropriate imaging technique to derive 3-D structures of biological nano-machines because of several reasons (Chiu et al., 2006; Frank, 2002). In single particle cryo-EM, samples do not need to be crystallized as in X-ray crystallography. Rather, specimens can be prepared in frozen, hydrated state at different sample conditions without chemical fixative or negative stain (Duboch et al., 1988). As the conditions attempt to mimic cellular conditions, often the frozen, hydrated samples represent a heterogeneous mixture of conformationally different particles. However, while this may be a drawback for conventional structure determination, single particle cryo-EM image processing techniques could be developed to sort out images of mixed conformations, thus capturing several states from a single experiment. Additionally, well-defined computational protocols can determine the 3-D structure of a sample directly from low dose images. Currently, the resulting reconstructions of conformationally rigid and uniform machines have achieved subnanometer (6-10 Å) resolutions (Chiu et al., 2005; Jiang and Ludtke, 2005). In this resolution range, secondary structure elements can be identified and high-resolution structures can be fitted to provide an understanding of the biological machine and its components (Chiu et al., 2002; Rossmann et al., 2005). Despite not being able to obtain atomic resolution structures of biological samples, cryo-EM continues to gain popularity in understanding biological processes as evidenced from the increasing number of publications (Figure 1) and the establishment of a public cryo-EM structure repository (http://www.ebi.ac.uk/msd-srv/emsearch/index.html) (Fuller, 2003).

A Single Particle Cryo-EM Experiment

As cryo-EM has assumed an increasingly important role in determining biological nano-machines, the complexity of imaging the samples to higher resolutions has also increased. However, the basic procedure (Jiang and Chiu, 2006; Serysheva et al., 2006) can be summarized as having two components: an experimental and a computational component (Figure 2). In the experimental portion of a cryo-EM experiment, the specimen must first be biologically purified. While not as stringent of a restriction as other structural imaging modalities, the specimen should be relatively “pure” in terms of both conformation and function, meaning that the individual particles in sample should generally have the same structure and function. The purified sample can then be suspended in a buffer depending on the sample and the intended experiments. Typically, only a small amount of material is needed. For initial testing, as little as 100 µl at concentrations of 0.1-1 mg/ml are required. Subsequent higher resolution structural studies may require additional amounts of sample, however in some favorable cases high resolution structures may be obtained from the initial imaging of the specimen.

Once a suitably purified specimen has been obtained, the sample must then be prepared for imaging in the electron cryomicroscope. This step involves freezing the specimen on a holey
grid (e.g. Quantifoil grid) which has been cleaned and pre-treated with glow discharging. 3-5 µl of sample can then be applied to the grid with the excess liquid blotted off with filter paper. At this point, the sample can be vitrified by plunging the grid with sample rapidly into a liquid ethane bath (Dubochet et al., 1988). To accomplish this, a variety of freezing apparatuses can be used from simple hand-operated devices, to pneumatic plungers or even temperature/humidity controlled plunging chambers from commercial companies. Once the sample has been frozen, it can then be stored almost indefinitely in a liquid nitrogen dewar or imaged immediately in the electron cryomicroscope.

The freezing step can often be the rate limiting step in the experiment. For any new specimen, it is generally necessary to perform trial-and-error freezing experiments to identify suitable conditions for obtaining a sufficiently thin layer of ice yet maintaining a reasonable number of randomly oriented particles across the holes of the holey carbon grid. Often variables such as specimen concentration, buffer, blot time, wait time, carbon support, temperature and humidity must be evaluated to achieve optimal imaging conditions. One of the more frequent challenges in this step is the presence of detergent, glycerol or sucrose which has been used to help solubilize, purify or store the specimens. For imaging in the electron cryomicroscope, these types of organic molecules must be removed without disrupting the integrity of the complex itself.

The third step in a cryo-EM experiment is imaging frozen, hydrated specimen in the electron cryomicroscope equipped with a cryo-specimen transfer device (Figure 2). The specimen grid is suspended in a cryo-specimen stage that can generally be operated at either liquid nitrogen or liquid helium temperatures. Since biological specimens are highly radiation sensitive, low dose imaging is necessary to record the images. The practical dosage ranges from 10-40 electrons/Å² depending on the specimen temperature and the intended resolution of the study. Typically, images are recorded at 1-3 µm underfocus in order to provide sufficient contrast to visualize the particles while still maintaining high enough resolution structural information. The imaged specimen can be recorded on photographic film or directly to a CCD camera. When using film, the data has to be subsequently digitized using a scanner, such as Nikon Super Coolscan 9000ED. In addition to their convenience, CCD cameras provide an additional benefit as the low frequency component of the image is enhanced (Booth et al., 2004), making it easier to identify the particles. Conversely, the CCD has an additional modulation transfer function that may “smear out” high frequency data. Previous experience with a commercially available Gatan 4 k × 4 k CCD camera has shown that the signal up to 2/5 Nyquist frequency can be retrieved and used in the reconstruction (Booth et al., 2004), meaning that subnanometer resolution data can be obtained at moderate microscope magnifications (i.e. 80,000 x).

In the second half of the cryoEM experiment, computational techniques are used to transform the 2-D images of the randomly oriented particles into an intermediate resolution 3-D structure, typically referred to as a reconstruction (Figure 2). The digital data, whether acquired directly from the CCD camera or digitized using a scanner, is subject to a series of data processing steps that determine the parameters associated with the contrast transfer function of the microscope and the envelope function of the images. These parameters serve to make corrections to the image data prior to merging the individual 2-D particle images into a single 3-D reconstruction.

There are numerous image processing packages such as Spider (Frank et al., 1996), IMAGIC (van Heel et al., 1996), MRC (Crowther et al., 1996), FREALIGN (Grigorieff, 1998), PFT (Baker and Cheng, 1996), XMIPP (Sorzano et al., 2004), IMIRS (Liang et al., 2002), SAVR (Jiang et al., 2001) and EMAN (Ludtke et al., 1999) that can be used to perform data processing and reconstruction steps. Conceptually, all the software packages use similar principles for image reconstruction. The reconstruction process is iterative, meaning the same procedure is applied to the raw experimental data multiple times, each time producing a slightly improved 3-D model. In the EMAN software suite (Ludtke et al., 1999), the iterative process involves first classifying each of the noisy raw particle images by comparing it to computational projections of the current 3-D model. Corrections to the effects of the contrast transfer function and envelop functions are made for each individual particle images prior to its classification. Classified particles are then rotationally and translationally aligned, and an average image is produced from the experimental data for each projection of the 3-D model. These averages are then used to construct the new 3-D model used for the next iteration of the reconstruction process. This extremely computationally intensive process is continued until the 3-D model is no longer improving. The 3-D model from the last iteration is then the final reconstruction of the specimen.

While the reconstruction represents the structure of the specimen in question, a considerable effort is required to decipher and ana-
Fig. 2 From sample to model using cryo-EM. Shown is a generic flow diagram illustrating the basic procedure in a cryo-EM experiment. In the first half of the procedure (left panel), the “experimental” portion, the sample is purified, vitrified and imaged, from which raw micrographs or CCD frames of the sample are collected. Once the images have been collected, the data is subjected to the “computational” portion of the experiment which includes image processing, reconstruction, segmentation and analysis as shown on the right panel.
lyze the architecture and composition of the biological nano-machine. As these complexes can be quite large and composed of multiple molecular components, it can be challenging to interpret, let alone just visualize the reconstructed density map at subnanometer resolutions. The first in dissecting the intricate structure of the complex is to identify the individual subunits and segment them from the reconstruction. Again, numerous software packages and approaches are available for this procedure (Bajaj et al., 2003; Baker, 2006; Dougherty and Chiu, 1998; Volkmann, 2002; Yu and Bajaj, 2005). The majority of the approaches rely on the ability to isolate discrete density based by creating a mask and utilizing symmetry information when present. In many instances, the isolation of individual components is a hierarchical procedure, first identifying larger sub-groups of proteins, such as an asymmetric unit in a virus, followed by progressive finer segmentations until individual proteins or small domains have been identified (Baker, 2006).

Once the individual structural components have been isolated, analysis of the individual components can then be done. At subnanometer resolution, this analysis includes the identification of secondary structure elements and fitting structures into the density map (Chiu et al., 2005; Chiu et al., 2002; Jiang et al., 2001). Additionally, new techniques have begun to arise that utilize the cryoEM density map as a constraint in building structural models (Mitra et al., 2005; Rossmann et al., 2005; Topf et al., 2006). These types of analysis are then combined with traditional genetic, biochemical and bioinformatics analysis to produce “higher resolution” structural models for the individual components. It is plausible that these individual structural models can then be integrated with the cryo-EM refinement, from which a more detailed structural and functional understanding of the complex can be gained.

**GroEL, a Protein Folding Machine**

With the relatively rapid growth and development of new technology in cryo-EM, it is important to demonstrate the fidelity and limitations in a cryo-EM experiment. For this purpose, it has been necessary to examine a specimen using the cryo-EM pipeline described in Figure 2 in which the high resolution X-ray crystallographic structure is known. The bacterial chaperonin, GroEL, has been the subject of numerous structural studies by both X-ray crystallography and cryo-EM, including the highest resolution single particle cryoEM reconstruction to date at 6 Å resolution reported today (Ludkte et al., 2004). GroEL, composed of 14 identical subunits and sometimes associated with the capping protein, GroES, is a protein folding machine, with a molecular mass near 1 million Daltons. Figure 3A shows an image of a frozen, hydrated GroEL recorded on a JEM-2010F cryomicroscope operated at 200 kV equipped with a Gatan cryo-specimen holder and 4 k × 4 k CCD camera. As discussed previously, the image contains particles randomly oriented and thus appears differently in the 2-D images. ~8000 individual GroEL particles were combined and used to compute the 9 Å resolution reconstruction (Figure 3B), based on the 0.5 criterion of the Fourier Shell Correlation technique, using the image processing package EMAN (Ludkte et al., 1999). At this resolution, it was possible to detect and analyze the GroEL monomer (Figure 3C). Using SSEHunter (M. L. Baker, unpublished), individual α-helices greater than two turns were identified in the monomeric subunit (Figure 3C). Additionally, large flat density regions, corresponding to sheets could be readily identified. To confirm the GroEL structure and the secondary structural elements (Figure 3D), an electron density map of a GroEL monomer (1OEL) (Braig et al., 1994) was fitted to the GroEL density, using FOLDHUNTER (Jiang et al., 2001), and compared (Figure 3D). The resulting comparison showed the relative accuracy in identifying nearly all of the secondary structure elements and illustrated the ability of the cryo-EM reconstruction to faithfully capture the native structure of GroEL. As such, the structure and the procedure used to generate the density map and model were validated. Experiments such as this one not only provide the necessary validation of the technique but also provide an excellent way to test new experimental and computational procedures.

**Challenges to High Resolution**

Modern cryo-EM instruments have a resolving power better than 3 Å even with imaging conditions used for the biological nano-machines at moderate magnification and low dose. Therefore, the question becomes if the instrumentation can achieve atomic resolutions, why is it not currently possible to reconstruct density maps to these resolutions? In fact, there are several plausible factors that currently limit high-resolution cryo-EM. First, electron beam induced specimen movement can blur the image anisotropically in a relatively unpredictable manner (Henderson, 2004). Though various attempts have been made to reduce this phenomenon, no general remedy has yet been introduced. Nevertheless, images of frozen, hydrated particles can be recorded in a liquid helium cryomicroscope (JEM-3000SF) with information contents beyond 6 Å as demonstrated from the visibility of the contrast transfer function rings from the power spectrum of the boxed-out particle images (Figure 4). Secondly, inadequacy of the reconstruction software to accurately assign orientations and/or improperly correcting the contrast transfer function and envelope function. Furthermore, conformational heterogeneity and the dynamic nature of the biological nano-machines, can limit the ability of the reconstruction software to accurately assign orientations and combine them in the 3-D reconstruction. As seen in X-ray crystallography map, different structural regions have different quality, usually referred to as a B-factor. Regions with high B-factors often represent regions of disorder or regions that are highly flexible. As the traditional single particle cryo-EM approach relies on averaging large numbers of individual particles, this type of flexibility, despite the same global structure, would produce reconstructions at resolutions limited by the extent of rigidity of the particle. Computational approaches have begun to address both these factors and specimen heterogeneity and may result in more accurate and higher resolution structures.

Challenges in cryo-EM are not restricted to specimen, imaging and reconstructing the specimen. As the reconstructions achieve higher resolutions, the density maps grow in size. Current visualization software is capable of interactive visualization; however larger maps are nearing the maximum size and dimensions for standard desktop visualization software. While one would also assume that the subunits are more completely defined and thus easier to segment in higher resolution structures, the finest structural detail that the density resolution range in fact can blur the boundaries between the subunits and noise. Structural analysis can also be complicated by higher resolution structures. X-ray crystallography and NMR have an extensive repertoire of software designed for building structural models. However, only limited algorithms and applications have been developed by those pushing the resolution envelope in cryo-EM and as such complete packages for structural analysis do not yet exist.

**Conclusion**

Cryo-EM is a maturing field in structural biology that can examine structures of macromolecular complexes at a broad range of resolutions and can bridge the information gap between cell biology and crystallography/NMR. CryoEM also affords investigators a unique glimpse at these large, dynamic machines, which generally are not amenable to traditional structural approaches. As the field continues to expand, new techniques emerge and can provide more insights. The past ten years have seen cryo-EM reconstruction improved from 20-30 Å to subnanometer resolutions and now stand poised to achieve near atomic resolution structures in the near future. The realization of this goal will ultimately result in making an impact in our understanding of biological processes and in structure-based drug design against human diseases.

**Acknowledgements**

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**References**


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Intracellular Transport and Kinesin Superfamily Proteins, KIFs: Genes, Structure, Dynamics, Functions and Diseases

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Introduction

Cells transport and sort various proteins and lipids following synthesis as distinct kinds of membranous organelles and protein complexes to the correct destinations at appropriate velocities. The intracellular transports are fundamental for cell morphogenesis, functioning and survival not only in polarized cells such as neurons and epithelial cells but also in all other cells. To elucidate this mechanism, we have identified kinesin superfAMILY proteins, KIFs based on the discovery of various kinds of crossbridges between microtubules and membranous organelles (Fig. 1) [1-6] and been characterizing KIFs using molecular cell biology, molecular genetics, biophysics, X-ray crystallography and cryoelectron microscopy. Recently we have identified all KIFs genes in mammals such as mice and human [27]. In this manuscript, I present our recent studies about the structure, dynamics and functions of KIF1A, KIF1Bβ, KIF17, KIF5s, KIF3, KIF2A and KIF4. Especially I focus on our works to reveal how the molecular motors move on microtubules processively.

Discovery of Kinesin Superfamily Motor Proteins, KIFs and Elucidation of their Functions

KIF1A, KIF1Bβ, KIF17, KIF5s, KIF2A and KIF4 are deeply involved in neuronal functions, network formation and activity dependent neuronal survival during development. KIF1A and KIF1Bβ are unique monomeric motors transporting synaptic vesicle precursors and play essential roles on neuronal function and survival (Figs. 2, 3, 4A) [6, 11, 19, 29]. Molecular genetic study revealed that KIF1Bβ is a responsible gene of a human hereditary neuropathy [29]. KIF1Bβ and KIF5 transport mitochondria from the cell body to periphery [9, 20]. KIF17 conveys NMDA type glutamate receptors, important for memory and learning, in dendrites through the interaction with scaffolding protein complex and NR2B subunit of NMDA receptors (Figs. 4A, B)[24, 32]. Transgenic mice study showed that overexpression of KIF17 improved spatial and working memory [31]. On the other hand, conventional kinesin (KIF5) transports AMPA type glutamate receptors in dendrites via GRIP1 and GluR2 interaction (Figs. 4A, B)[30].

The middle motor domain type KIF2A is fundamental for correct wiring of brain by suppressing elongation of axon collaterals through depolymerizing microtubules in growth cones (Fig. 4A)[6, 10, 33]. Recently using X ray crystallography of KIF2C at ADP state and ATP like state, we have elucidated how unique KIF2 depolymerizes microtubules at their ends [35].

KIF3 is ubiquitously expressed [6, 7, 13, 16]. Our gene targeting studies demonstrated that KIF3 is essential for determination of left-right asymmetry of our body through formation of monocilia of node cells which rotate and generate leftward flow of extra embryonic fluid, nodal flow. This nodal flow is critical to turn on switches of a gene cascade expressed strictly at left side, and determines left-right asymmetry. Our recent studies finally uncovered the morphogens which are conveyed toward left and play critical roles on L/R determination [39, 40]. Actually vesicles containing Shh and retinoic acid are released from nodal cells dependently on the FGF signaling and Shh and retinoic acid are conveyed to the left by the nodal flow [39]. Thus, KIF3 is essential for left-right determination of our body [42].

Conditional gene targeting study of KAP3, an associated protein of KIF3 motor complex, caused suppression of KIF3 function and revealed that hyper proliferation of progenitor cells in the neuroepithelium occurred and resulted in formation of brain tumors [41].

This is because KIF3 suppresses tumorigenesis by transporting N cadherin-β catenin complex from Golgi to the plasma membrane which works as a transcriptional factor with T cell factor and enhances cell proliferation as a signaling molecule down stream of Wnt canonical pathway in the nucleus [41].

KIF4 controls the activity-dependent survival of postmitotic neurons by regulating PARP-1 activity in brain development. In brain development [6, 8, 43], apoptosis is a physiological process that controls the final numbers of neurons. The C-terminal domain of KIF4 is a module that suppresses the activity of poly(ADP-ribose)polymerase-I(PARP-1), a nuclear enzyme known to maintain cell homeostasis by repairing DNA and serving as a transcriptional regulator. When neurons are stimulated by membrane depolarization, calcium signaling mediated by CaMKII induces dissociation of KIF4 from PARP-1, resulting in upregulation of PARP-1 activity, which supports neuron survival. After dissociation from PARP-1, KIF4 enters into the cytoplasm from the nucleus and moves to the distal part of neurites in a microtubule-dependent manner [43]. This suggested that KIF4 controls the activity-dependent survival of postmitotic neurons by regulating PARP-1 activity in brain development [43].

Our very recent study unraveled also that KIF5 transports mRNAs such as CaMKIα mRNA and Arc mRNA in dendrites through the interaction of KIF5 tail and a large RNA-Transporting protein complex (~1000s containing hnRNP-U, Pur α and β, PSF, DX1, DDX3, SYNCRIP TLS, NonO, HSPC117, ALY, CGI-99, Staufen, three FMRPs and EF1α (Fig.4A, B)[37].

Thus, KIFs play a number of significant roles not only on various cell functionings by transporting important membranous organelle, protein complexes, and mRNAs but also play unique and important functions on fundamental developmental events such as left-right asymmetry, brain wiring, activity dependent...
Fig. 1 Quick-frozen, deep-etched axons in which various types of crossbridge (arrows) are identified between membranous organelles and microtubules. (a) A crossbridge (arrow) composed of two heads and a long stalk (~25 nm). (b) Only globular heads (arrows) are recognizable between a membranous organelle and a microtubule. (c) Crossbridges (arrows) between mitochondria and microtubule are short and have small heads. Bar, 50 nm. Reproduced with permission from Hirokawa [14].

Fig. 2 The domain structures of principal KIFs. The motor domains are shown in purple. The ATP-binding consensus sequence is indicated by a thin red line and the microtubule-binding consensus sequence by a thick red line. The dimerization domains, forkhead-associated domains and pleckstrin homology domains are shown in yellow, orange, and dark blue respectively. The number of amino acids in each molecule is shown on the right. N-kinesins are shown in green, M-kinesin in pink and C-kinesin in pale blue.

Fig. 3 Principal members of KIFs observed by low-angle rotary shadowing. Diagrams, constructed on the basis of electron microscopy or predicted from the analysis of their primary structures, are shown on the right (the large red ovals in each diagram indicate motor domains). Reproduced with permission from Hirokawa [18]. Scale bar, 100 nm.

Fig. 4A (a) A typical neuron, extending several dendrites (left) and a single thin axon (right) from the cell body. In the axon, microtubules are unipolar, with the plus ends pointing towards the synaptic terminal. Microtubules form special bundles at the initial segment, which might serve as the cue for axonal transport. Tubulovesicular organelles are transported anterogradely along microtubules by KIFs. In the growth cone of an axon collateral, KIF2A controls microtubule dynamics and the extension of collaterals. Rough endoplasmic reticula are abundant in most parts of the cell body, except for the axon hillock. Dendrites contain some rough endoplasmic reticula. Microtubules have mixed polarity in proximal dendrites, but are unipolar in distal dendrites, with the plus end pointing away from the cell body. Membranous organelles and RNA-containing granules are transported along microtubules by KIFs. (b) Mitochondria are transported by KIF5 and KIF1B. KIF3 transports vesicles associated with fodrin. KIF1A and KIF1B both transport synaptic vesicle precursors. KAP3, kinesin superfamily-associated protein 3. (c) In dendrites, KIF5 transports vesicles containing AMPA (-amino-3-hydroxy-5-methyl-4-isoxazole propionic acid) receptors through an interaction between KIF5 and GRIP1 (glutamate receptor-interacting protein 1). RNA-containing granules are also transported by interacting directly with KIF5. KIF17 transports vesicles containing NMDA (N-methyl-D-aspartate) receptors by interacting through the LIN complex, a tripartite protein complex containing mammalian homologues of the Caenorhabditis elegans presynaptic density zone (PDZ) proteins LIN-2, LIN-7 and LIN-1065. Reproduced with permission from Hirokawa and Takemura [42].
neuronal survival, suppression of tumorigenesis and higher brain functions such as memory and learning [14, 18, 38].

**How the Molecular Motor Moves on the Microtubules Processively**

Here, we discuss the mechanism underlying motor motility. We identified KIF1A motor, which exists as a monomer in solution [6, 11]. It was an important finding because all the motors that had been identified before KIF1A are dimeric two-headed motors; for example, myosins that move along actin filaments, dyneins that generate the movements of cilia or flagella, or conventional kinesin. Therefore, the “walking” model or a “hand-over-hand” model is a widely accepted model of the processive movement, that is the movement of motor molecules along the rail without detaching for some distance (Fig. 5)[44]. In other words, it had been widely accepted that a motor needs two legs, just like when we walk. When one foot steps forward, the other foot needs to be firmly attached to the rail for a motor to be able to “walk” without detaching from the rail. With this theory, a single-headed motor molecule is not expected to move processively along the rail, because a single-headed motor would dissociate from the rail when it steps forward [45, 46].

**Processive biased Brownian movement of KIF1A**

To determine whether KIF1A is a processive motor, we produced the shortest motor domain construct of the KIF1A molecule, C351, and labeled it with a fluorescent Alexa dye. A similar construct was produced for conventional kinesin [22]. We constructed a low-background video-intensified microscope and then visualized the behavior of single molecules, that is, their dynamics. It was revealed that a single KIF1A molecule moves along a microtubule processively over a distance of more than 1 µm (Figs. 6a and 6b-C shaded bar). The movement of single C351 molecules on the microtubule is not smooth, and usually appears to be oscillatory (Figs. 6a and 6b-D). Although on average they move unidirectionally, a single C351 molecule sometimes pauses for a while, or moves backward for a short distance, and then forward. To quantitatively analyze this apparently oscillatory movement, the displacement of placement was plotted (Fig. 6b-F). The plot fitted well with a normal distribution whose mean and variance increased linearly against time. The linear increase of mean indicates a unidirectional constant-velocity movement on average. The linear increase of variance indicates a linear accumulation of random noise, as observed in Brownian movement [47]. Thus, the distribution of displacement of C351 suggests that it was a biased Brownian movement. In contrast, a dimeric conventional kinesin molecule, K381, moves smoothly unidirectionally (Figs. 6b-E and 6b-D open bar). The distribution of its displacement fitted well with a normal distribution with linearly increasing mean and a constant variance (Fig. 6b-G). The latter can be explained by the error in position measurement.

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Fig. 4B (a) Schematic model and binding domains of KIF5 and kinesin light chain (KLC). Top, schematic model of KIF5 associating with KLC. The KIF5 dimer associates with two KLCs to form a heterotrimer. The globular motor domains of KIF5 are shown on the left, followed by the neck, stalk and carboxy (C)-terminal tail, with which KLC associates to form fanlike ends. Middle, the domain structures of KIF5 and binding sites for KLC, GRIP1 (glutamate receptor-interacting protein 1) and RNA-containing granules. KIF5 consists of motor, neck, stalk and tail domains. The binding site for KLC is near the C-terminal end of the stalk region (amino acids 775–802); those for GRIP1 and RNA-containing granules are in the C-terminal tail (amino acids 807–934 and 865–923, respectively). The C-terminal tail cargo-binding site of KIF5 overlaps with the cargo-binding site of fungus KIF, which lacks KLC. Bottom, the domain structure of KLC and the binding sites for KIF5 and JIPs (scaffolding proteins of the c-Jun amino (N)-terminal kinase (JNK) signalling pathway). KLC contains six TPR (tetratricopeptide repeat) motifs. The binding site for KIF5 is in the N-terminal portion of KLC and JIPs bind to the TPR motifs. (b) The C-terminal tail of KIF5 binds RNA-containing granules (left) and AMPA (α-amino-3-hydroxy-5-methyl-4-isoxazole propionic acid) receptor subunit GluR2-containing vesicles (right), and transports them to dendrites. The direct binding partner of RNA-containing granules is unknown. Binding to the C-terminal tail of GluR2 is mediated by GRIP1. (c) The TPR motif of KLC binds to JIPs and transports APP (amyloid precursor protein)- and APOER2 (apolipoprotein E receptor 2)-containing vesicles to axons. The phosphotyrosine-binding domain of JIPs interacts with APOER2 and APP. However, it has also been proposed that APP binds directly to KLC. Reproduced with permission from Hirokawa and Takemura [42].
We further analyzed the movement of C351 and K381 by plotting mean square displacement (MSD, \( \rho(t) \)) against time, which is a convenient quantitative measure of stochastic movement (Fig. 6b-I). The MSD plot of C351 (Fig. 6b-I open circle) fitted well with biased Brownian movement,
\[
\rho(t) = 2Dt + \nu^2 t^2,
\]
where \( D \) is the diffusion coefficient and \( \nu \) is the mean velocity. The MSD plot of C351 fitted well with
\[
D = 44,000 \pm 1200 \text{ nm}^2/\text{s} \quad (2)
\]
and
\[
\nu = 140 \pm 10 \text{ nm/s}. \quad (3)
\]
The estimated value of \( D \) is much larger than the value expected from fluctuation in ATPase activity (<2400 nm\(^2\)/s), but it is in good agreement with the value previously reported for one-dimensional Brownian movement in microtubule-motor protein systems. In contrast, the MSD plot of K381 (Fig. 6b-I closed square) fitted well with
\[
D = 2200 \pm 1000 \text{ nm}^2/\text{s} \quad (4)
\]
and
\[
\nu = 710 \pm 10 \text{ nm/s}. \quad (5)
\]
and the fluctuation in K381 movement can be explained by the fluctuation in ATPase activity.

The difference in the degree of fluctuation of movement between C351 and K381 is illustrated by the plot of the diffusion term,
\[
\rho(t) - \nu^2 t^2. \quad (6)
\]
The movement of C351 is about 20 times as diffusive as K381 (Fig. 6b-I). This heavily stochastic nature of the movement cannot be explained by the error of position measurement or the Brownian noise, because these cannot accumulate and only contribute as constant terms to the diffusion term of MSD or the variance of displacement. Furthermore, our single-motor assay is free from the Brownian noise because the position of a fluorescent spot directly reflects the position of a motor molecule. These results are the first clear experimental demonstration that a motor could move by a biased Brownian movement.

“K-loop” is essential for processivity

The next question is why a one-headed monomeric motor can move processively along microtubules without detaching. It was suggested that the binding between motor and microtubule is mediated by electrostatic interactions. The microtubule surface is mainly negatively charged; therefore, we thought that KIF1A might have a highly positively charged region and we attempted to identify this region. We found a region with five lysines in tandem, and named this region the “K-loop” [22]. We considered that this highly positively charged region may play important roles and we confirmed it to be so. When mutants that have fewer lysines in the K-loop were produced, the processivity of the motor decreases, as determined by single-motor motility assay [48]. In other words, the duration of movement...
along a microtubule becomes shorter for the
mutant KIF1A. The turnover rates ($k_{cat}$) of
these mutants are the same level as that of the
original construct, but K351 (micro-
tubule concentration for half-saturation of
ATPase), which is a measure of the average
affinity to microtubule throughout the ATPase
cycle, is significantly affected.

The time constant of the mechanical proces-
sivity ($\tau_{kin}$) of C351 determined by single-
molecule-motor assay is 6.1 ± 0.8 s (Fig. 6b-
A), which agrees well with the time constant
of kinetic processivity ($\tau_{kin}$) of 6.3 s deter-
mined by microtubule-activated ATPase assay.
In comparison, the time constant of the
mechanical processivity of K381 ($\tau_{kin}$) is 2.6 s and
that of kinetic processivity ($\tau_{kin}$) is 2.0 s (Fig.
6b-B), that is, about one-third of those of
C351, indicating that monomeric KIF1A has a
higher processivity than dimeric conventional
kinesin.

The kinetic index of processivity, which
indicates the number of ATPase cycles per
motor-microtubule encounter, is 690 for C351.
On average, C351 hydrolyzes nearly 700
ATPs before detaching from the microtubule.
This is more than five times the number of
ATPs hydrolyzed by the dimeric kinesin
K381, and more than 40 times that hydrolyzed
by the monomeric kinesin K351. Biased stepwise movement during ATP hydrolysis cycle

We then analyzed the detail of movement
by optical trapping nanometry [34]. For this,
we attached a 0.2-µm-diameter bead to one
end of a monomeric KIF1A construct, which
contains almost solely the motor head domain
and cannot dimerize. We then placed the beads
on a polarity-marked microtubule fixed to a
coverglass and performed optical trapping, that
is, by pulling a bead with a laser beam, the
optical tweezer, the movement of KIF1A is
amplified as the movement of the bead.

A region called the “neck linker” at the C-
terminal of the motor domain is proposed to
play important roles in the motility of conven-
tional kinesin [45, 49]. To determine whether
this is the case for the biased Brownian move-
ment of KIF1A, a bead was attached to the N-
terminal or C-terminal of the KIF1A motor
domain. We also attached KIF1A to beads
using methods that prevent dimerization.

Binding beads at the N-terminal or C-terminal
of KIF1A does not make any difference in the
results of optical trapping nanometry; there-
fore, this indicates that the neck linker does not
significantly contribute to at least motility
biased stepwise movement.

The KIF1A attached beads showed a clear
directional stepwise movement. In addition,
they was a single ATP hydrolysis pro-
duces a single mechanical step. Furthermore, it
was shown that the step size is not fixed, but
distributed approximately in multiples of 8 nm
(Fig. 7d and e). This shows that the step size
is distributed in both the directions of plus
and minus ends, but step sizes are all in multi-
plies of 8 nm. Therefore, the beads moved
backward and forward in step sizes of multi-
plies of 8 nm, but the net direction of the bead
movement is towards the plus end, indicating
biased Brownian movement. Because the size
of the tubulin monomer is 4 nm and that of the
heterodimer is 8 nm, the microtubule is pre-
dicted to have high affinity sites every 8 nm.

Next, to analyze at which steps the move-
ment is biased towards the plus end, the move-
ment was observed in the presence of ATP at a
low concentration. The analysis showed that in
the ADP-bound state, KIF1A was in Brownian
motion, and when it released ADP and had no
nucleotides, it bound tightly to the micro-
tubule. At that moment, KIF1A moved
towards the plus end by about 3 nm on aver-
age. This average distance of 3 nm is
explained as follows: If a motor moves twice
towards the plus-end over a distance of 8 nm
and once towards the minus end over a dis-
tance of 8 nm once, the net distance it moved is
8 nm towards the plus end. However, it took
three steps to make that movement. If 8 nm is
divided by 3, the average movement of 2.66
nm per step is obtained. Therefore, KIF1A
always moves at step sizes of multiples of 8 nm,
but it moves towards the plus end over a dis-
tance of 3 nm on average. It was also
demonstrated that when ADP is released,
KIF1A makes a biased movement towards the
plus end. In summary, the optical trapping
showed that KIF1A is in Brownian movement
in the ADP-bound state, and when ADP is
released, it moves towards the plus end over a
distance of 3 nm on average (Fig. 6d). This
model also agrees well with the results of X-
ray crystallography analysis, but we will dis-
cuss it later.

K-loop/E-hook interaction sustain Brownian movement in weak-binding state-Tarzan model

We also studied the mechanism of biased
Brownian movement by cryoelectron
microscopy [12, 23]. The motor domain of
KIF1A, C351, was bound to the microtubule
in an ATP-like strong binding state and its
structure was studied by cryoelectron
microscopy at 15 Å resolution. In a state bound
to a nonhydrolyzable analog of ATP, AMP-
PNP, the KIF1A motor domain bound to
microtubule protofilament like koala with three
binding sites, namely MB1, MB2, and
MB3 (Figs. 7a and e). When this was com-
pared with the structure of KIF1A, a unique fea-
ture of KIF1A was found to be the high promi-
nence of MB3. The next step was to determine
which primary sequences, that is, amino acid
sequence, form the MB1, MB2, and MB3
binding sites.

The X-ray crystallographic atomic structure
of KIF1A was not available at the time, there-
fore, the available conventional kinesin atomic
model was docked. Because the amino acid
sequence of the motor domain of KIF1A have
60% similarity to that of conventional kinesin,
certain parts would fit and others would not,
revealing the differences. The docking showed
that MB3 corresponded to the loop L12, that
is, the K-loop region, and MB1 and MB2 cor-
responded mainly to L8 and L11.

When the tubulin atomic model was also
docked, another important feature was
revealed, that is, the flexible C-terminal of
tubulin can interact with the K-loop. This was
confirmed by the cleavage of the C-terminal of
tubulin [48]. Because this C-terminal region
contains many glutamates (E in one-letter
code), we named this region the “E-hook”
[48]. It was also suggested that the interaction
between the E hook and K loop is specifically
important in the ADP-bound state. Furthermore,
to directly show that the K-loop
coincides with MB3, we labeled the K loop
with colloidal gold cluster by introducing reac-
tive cysteine and examined it by cryoelectron
microscopy. The gold-cluster labeling unam-
biguously proved that MB3 contains the K
loop.

From these studies, we would like to propose
a model for the biased Brownian movement of
KIF1A called the Tarzan model (Fig. 7d).
Tarzan is the KIF1A motor domain, and it is
stretching its arm, the K-loop, upwards and
grasping a tether that hangs from the micro-
tubule protofilaments composed of α- and β-
tubulin. The tether is the flexible C-terminal E
hook of tubulin. In the ADP-bound state,
Tarzan does the Brownian motion via the
interaction between the K loop and E-hook.

Drag force, diffusion, might reflect the fluctua-
tion of the flexible tether between KIF1A’s K
loop and tubulin’s E hook. Upon the hydroly-
sis of ATP, Tarzan releases the tether and
grabs another tether, but in doing so, move-
ment has bias towards the plus end.

Conformational changes in switch I and II during ATP hydrolysis

We then studied how the bias works by
examining ATP hydrolysis steps by X-ray
crystallography and cryoelectron microscopy
(Fig. 8) [28]. First, the ADP-bound state and
AMP-PCP-bound state of KIF1A were stud-
ied. The AMP-PCP state is considered to rep-
resent one of the ATP-like-states called preco-
merization. X-ray crystallography revealed
that switch I and II regions, which form a
nucleotide-binding pocket interposed with the
bridging water molecule and hydrogen bonds,
show marked conformational changes. First,
the switch I region forms a short β-hairpin
structure in the ATP-like state, but it changes
to a helix flanked by two short loops in the
ADP-state. In addition, switch I region is clos-
er to switch II region in the ATP-like state,
resulting in the closure of the nucleotide-bind-
ing pocket. Second, in the switch II region,
which is composed of the α4 helix and loop
L11, the α4 tilted about 20 degrees and partly
melts and L11 extends in the ATP-like state.

We then docked the atomic structures to
cryoelectron microscopic images. Cryoelectron
microscopy revealed that the “long axis” of
the KIF1A motor domain in the ATP-state rotates
~20 degrees compared with that in the ADP-
state. This suggests that this rotation is a specula-
tion, but this suggests that although the
α4 helix tilts ~20 degrees in the crystal
structure, when the motor is bound to the micro-
tubule it remains fixed to the microtubule and
the motor itself rotates relative to the micro-
tubule. We then analyzed additional states of ATP
hydrolysis [36]. For this purpose, we produced a
very short motor domain construct, C340.
There are several ATP analogs that mimic the
different states of the chemomechanical cycle
of kinesin motors. First, three analogs mimic
the strong-binding states: AMP-PCP, a nonhy-
drolyzable analog, mimics the precessima-
tion state; AMP-PNP, also a nonhydrolyzable
analog, mimics the next prehydrolysis state;
and ADP-AlFx mimics the early ADP-Pi state, in which ATP hydrolysis begins. ADP-Vi mimics the late ADP-Pi state, in which the association with the microtubule is the weakest, and is considered to be an actively detaching state (Fig. 8c-f). After that is the ADP state, a weak-binding state. As discussed above, we solved the AMP-PCP and ADP states by X-ray crystallography in a previous study. Therefore, we decided to determine three additional states, the AMP-PNP, ACP-AlFx, and ADP-Vi states; we have solved five states in total (Figs. 8b-e).

Comparing the five different states, the most significant conformational changes occur in switch I and II regions (Figs. 8c-f). In the presomerization (AMP-PCP) state, ϒ-phosphate does not interact with any regions (Fig. 8c). In the prehydrolysis (AMP-PNP) state, ϒ-phosphate interacts with Ser215 and Gly251 (Fig. 8d). The switch I region elongates and changes its shape from a β-hairpin to a loop. Concomitantly, loop L11 in the switch II region extends downwards. In the early ADP-Pi (ADP-AlFx) state, a hydrogen bond between ϒ-phosphate and Gly251 in switch II is broken and L11 is raised (Fig. 8e). The raised conformation of L11 triggers a slight tilt of the α4 helix. In the late ADP-Pi (ADP-Vi) state, ϒ-phosphate is released from the nucleotidedocking pocket through the back door (Fig. 8f). This induces different interactions: loop L11 shortens and the elongated α4 helix tilts further.

**KIF1A alternately uses two loops to bind microtubules**

We docked the atomic structures of KIF1A and tubulin (Fig. 9)[36]. In tubulin, helices H11 and H12 mainly serve as the rail for KIF1A movement. In the strong-binding prehydrolysis (AMP-PNP) state, L11 is elongated and extends downwards binding to H11', which is between H11 and H12 (Fig. 9a). In the next early strong-binding ADP-Pi (ADP-AlFx) state, an early stage of hydrolysis, the extended L11 begins to rise (Fig. 9b). In the next late ADP-Pi state (ADP-Vi) state, the loop L11 is completely raised, but the loop L12 is also raised; therefore, the interaction of KIF1A with the microtubule rail is the weakest (Fig. 9c). This is an actively dissociating state. After the release of Pi in the ADP state, L12 extends downwards and binds to the E-hook, which is the C-terminus of tubulin (Fig. 9d). At this stage, the interaction between K-loop (L12) and E-hook, similar to the interaction between Tarzan’s arm and the tether, causes the Brownian movement (Fig. 7d). Because of this, the motor does not dissociate from the rail in spite of the fact that it is in the weak-binding state. Therefore, Brownian movement is the underlying force for the motor movement, and when ADP dissociates, KIF1A binds to the microtubule with bias towards the plus end, probably due to the presence of higher affinity sites on the plus end of tubulin.

We tested this hypothesis of the alternate use of two loops by introducing mutations to L11 and L12 and observed changes in the binding between KIF1A and microtubules [36]. In the AMP-PNP state, introducing mutations in L11 resulted in a decreased strength of binding. In contrast, in the ADP state, introducing mutations in L12 resulted in a decreased strength of binding. These results confirmed that L11 is used for binding at the AMP-PNP state and L12 is used for that at the ADP state. In addition, when the strength of binding between KIF1A and microtubules was compared at different ATP hydrolysis steps in wild type constructs, ADP-Vi (late ADP-Pi) state was the weakest binding state and KIF1A actively dissociates from microtubules in this state.

In summary, KIF1A uses L11 and L12 alternately for binding to tubulin (Figs. 9a-d). In the ATP-like prehydrolysis state, KIF1A extends L11 and binds to the H11’ helix of tubulin. Then L11 is raised, and KIF1A dissociates from tubulin in the late ADP-Pi state. In the ADP state, KIF1A extends L12, binding to the E-hook, and makes a Brownian movement. Therefore, energy derived from hydrolysis of ATP is used to dissociate from the microtubule at the late ADP-Pi state. This strategy is also used when kinases phosphorylate their substrates or when heterotrimeric guanine nucleotide-binding proteins (G proteins) interact with their target molecules (Figs. 9e-h). In both cases, energy derived from the hydrolysis of nucleotides is used for dissociation from the
substrates or target molecules. Therefore, it was suggested that this is an evolutionarily conserved mechanism for nucleotide-binding proteins including kinases, G proteins, and motor proteins. The movement itself of motor proteins depends on the Brownian movement.

We would like to add some detailed discussion here. One of them is if neck linker regions play any roles in the movement of motor proteins by biased Brownian movement. The neck linker regions, which are located at the C-terminus of the motor domain of N-kinesins, are proposed to play important roles in dimeric motor movement. The neck linker of KIF1A is docked on the motor domain when in the ATP-bound state, but undocked when in the ADP-bound state, making conformational changes [28]. However, it is not likely that the neck linker contributes to biased Brownian movement, because results of optical trapping experiments were unaffected when beads were attached either to the N-terminus or C-terminus of the motor domain [34]. Another issue that needs to be discussed is the velocity achieved by biased Brownian movement. When a single molecule is bound to a bead and moves through the mechanism of Brownian movement, the bead moves at ~0.2 \( \mu \text{m/s} \), which is slower than the velocity observed in microtubule gliding assays. However, with the clustering of a few KIF1A molecules on the bead surface, but without dimerization, the bead moves much faster. This enhancement can be explained from the nature of biased Brownian movement. The increase in velocity is caused by the suppression of the backward movement, which is caused by the presence of multiple motors; this results in an increase in the efficiency of forward movement, that is, the plus-end-directed movement.

References


Ultrahigh Pressure Earth Science: Applications of TEM and FIB Techniques for Study of Core-Mantle Boundary Region of Earth

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A laser heated diamond anvil cell (LHDAC) has been used to generate pressure and temperature exceeding the core-mantle boundary conditions, i.e., 130 GPa and 3000 K. The focused ion beam (FIB) method for preparation of the recovered samples and the analytical transmission electron microscope (ATEM) for their characterization are the ideal tools for studying the recovered samples from the Mega-bar conditions.

The partitioning coefficient of Fe and Mg between post-perovskite (PPv) and magnesiowustite (Mw) $K_{Pv\text{Mw}} = 0.30$ is larger than that between perovskite (Pv) and Mw $K_{Pv\text{Mw}} = 0.12$ keeping a constant value up to the PPv phase boundary. The density jump associated with the post-perovskite transition combined with the compositional change associated with the change in the partition coefficient at Pv-PPv phase boundary is 1.7%. Thus, the post-perovskite bearing assemblage in the lowermost mantle has negative buoyancy and tends to stabilize the region gravitationally against plume upwelling.

We have conducted a reaction experiment between molten iron and post-perovskite at the conditions equivalent to the core-mantle boundary (CMB). Significant amounts of oxygen up to 6.3 wt.% and silicon up to 4.0 wt.% are dissolved in metallic iron, and the solubility of silicon and oxygen in metallic iron can readily account for the density deficit of the core. The dihedral angle between the PPv and molten iron is around 67 degrees. A small amount of molten iron about 2 vol.% (1 wt.%) can be tapped by PPv at the base of the lower mantle, although percolative separation of metallic melt is effective. The core metal trapped in the PPv region can produce the core signature of the plume source at the base of the lower mantle. The partition coefficient of potassium between metallic iron and K-silicate, $D_K$, is determined to be $D_K \approx 0.15$ at 134 GPa and 3500 K. The total potassium concentration in the core is about 35 ppm or $4 \times 10^{-3}$ ppm $^{40}$K, which could produce 0.23 TW of radiogenic power in the core assuming a primitive mantle concentration of potassium of 240 ppm.

Introduction

The Earth can be divided into three layers, crust, mantle, and the core. The study of the material science of the core has been limited due to a difficulty to produce the extreme conditions of the core-mantle boundary (CMB) (130 GPa and 3000-3500 K) and the core (360 GPa, 5000-7000 K). There is seismological anomaly, such as low velocity, preferred orientation, and high attenuation of the seismic waves based on the seismological observations. Therefore the bottom of the lower mantle, CMB, and the interior of the core are the new frontier for the material science of the Earth.

Recent progress of high-pressure techniques made it possible to achieve the conditions of the center of the Earth. A laser heated diamond anvil cell (LHDAC) [1, 2] has been used to generate pressures and temperatures exceeding the core-mantle boundary conditions, i.e., 130 GPa and 3000-3500 K. We can now study the recovered samples from the conditions of the core-mantle boundary (CMB). Significant amounts of oxygen up to 6.3 wt.% and silicon up to 4.0 wt.% are dissolved in metallic iron, and the solubility of silicon and oxygen in metallic iron can readily account for the density deficit of the core.

Experimental Procedure

High pressure generation by diamond anvil cell

High pressure and temperature experiments were carried out using the double-sided LHDAC technique [4]. A Mao-Bell type diamond anvil cell was used to generate high pressure. The sample was directly loaded into the sample hole (with a diameter of 70 ~ 200 $\mu$m) of a pre-compressed Re gasket together with some ruby chips. NaCl or silicate powder was used as a thermal insulator between layers of the pure silicate or NaCl powders and loaded into a 50~80 $\mu$m hole drilled in a rhodium gasket for the reaction experiments on the metallic iron and silicates. A powdered or single crystalline San Carlos olivine was embedded between two layers of NaCl powders as the thermal insulator in the gasket hole.

Pressures before and after heating were measured at room temperature by the ruby fluorescence method using ruby chips scattered on the culet surface of diamond anvils [5] and averages of those values were used as experimental pressures. Pressures in some runs were determined before and after heating at room temperature, based on the Raman $T_{\text{D}}$ mode at the culet of diamond anvil [6]. The Raman spectra of diamond were measured using a JASCO NRS-2000 micro-Raman spectrometer. The 514.5 nm line from an Ar ion laser was used for excitation, and the laser spot on the culet of the diamond anvil was about 4 $\mu$m in diameter.
the results with a resolution within 5 nm.  

X-ray diffraction at high pressure

We have conducted in situ X-ray diffraction for phase identification of the runs. In situ X-ray diffraction measurements were conducted at BL18C of Photon Factory, High Energy Accelerator Research Organization, Japan (KEK-PF). X-ray diffraction spectra were collected at the conditions of high pressure after quenching to room temperature using an angle dispersive method and an imaging plate. The incident X-ray beam was monochromatized to a wavelength of 0.6130 Å and collimated to 40 µm in diameter. Typical exposure time for X-ray diffraction was 30 min. The collected images were integrated as a function of 2θ in order to obtain a conventional one-dimensional diffraction profile. We determined the pressure based on lattice parameters determined by the X-ray diffraction of ε-Fe and its equation of state in some runs containing metallic iron. The uncertainty in this pressure determination was smaller than ±2 GPa and generally consistent with the pressure values measured by the other methods. The phase identification of the run products was made after quenching from high temperatures at high pressure and room temperature by the in situ X-ray diffraction.

High temperature generation by laser heating

Samples were heated up to 3500 K at pressures in excess of 100 GPa using a high power multimode continuous wave Nd: yttrium-aluminum-garnet (YAG) laser (λ=1.064 µm, LEE LASER 8100MQ) [4]. The double-sided heating technique was used to minimize radial and axial temperature gradients in the sample. A single-sided laser heating was also applied in some experiments with the same type laser at the BL-13A at KEK-PF in Tsukuba, Japan [4]. In the experiments to study the phase transition of ferrous iron bearing San Carlos olivine samples, no laser absorber was used to avoid contamination and reaction with the starting materials. In the experiments on the reaction of metallic iron and silicate phases, a metallic iron foil or a mixture of metallic iron and the silicate phases such as olivine, orthopyroxene, or adularia sandwiched with the pure silicates thermal insulators were placed in the sample hole of the rhenium gasket. Metallic iron was worked as the laser absorber of the sample in these configurations. The laser spot with a focused size of about 40-50 µm in diameter was slowly scanned (with a speed of less than 10 µm/sec) to heat the entire sample homogeneously in order to minimize the stress and avoid chemical differentiation in the sample by long heating duration with steep temperature gradient at a fixed position.

Temperatures were determined from both sides by fitting the emission spectra from the heated sample to the gray body formula [4, 7] and were maintained at 1500-3500 K for 10 to 90 min. The fluctuation of temperature during heating at a constant laser power was ±100 K at around 1500 K and ±250 K at around 3500 K.  

Preparation of the TEM foils by FIB and characterization of run products by TEM

The samples in the rhenium gasket were prepared with the focused ion beam system, FIB (JEOL JEM-9310FIB), and the pick-up method for TEM observation [3]. Grooves were made in the specimen recovered from the diamond anvil cell by using gallium ion beam in the vicinity of the area to be analyzed by the electron microscope TEM/STEM. A block piece was recovered on the stage of a molybdenum-grid using a glass pipette attached to a manipulator under an optical microscope. The block piece was thinned by gallium ion beam again to prepare TEM foils. The foils were cleaned by mild Ar milling in the final stage of the sample preparation. Thus, a thin film with a uniform thickness of 100 nm suitable for ATEM measurements was prepared in this work.  

Fig. 1. The sample (Run FeAd4) prepared by FIB with a Ga ion beam for TEM observation (Upper). A block specimen was prepared from the center part of the sample in a rhenium gasket and was picked out using the manipulator. FIB processing was conducted by monitoring the scanning ion beam (SIM) images (Lower). A TEM image of the thin film of the sample prepared by FIB from the surface to the depth of about 15 mm with a uniform thickness ~100 nm. A metallic iron layer is sandwiched and embedded in K-silicate.

Partitioning of Mg and Fe between Magnesiowustite, perovskite, and post-perovskite

Partitioning of Mg and Fe between the coexisting phases at the bottom of the lower mantle is important to evaluate the density of
this region, since the amount of Fe in minerals affect the mean density of this region. We clarified the Mg and Fe partitioning between perovskite (Pv) and magnesiumwustite (Mw) and that between post-perovskite (PPv) and magnesiumwustite (Mw). Experimental conditions and results are summarized in Table 1. Detailed results are given in Kobayashi et al. [11]. We determined that the partition coefficients of Pv and Mw, $K_{Pv/Mw}$, is in the range from 23.0 GPa to 95.4 GPa at a pressure of 1500 K. The fraction of Fe produced from iron dissolved in the metallic phase was determined at 123.6 GPa and 300 K after laser heating and temperature quenching is given in Fig. 2. Although a couple of unknown minor peaks were overlapped in the pattern, PPv (post-perovskite) phase with a space group of Cmcm and Mw are clearly observed as shown in this diffraction pattern. The PPv phase was observed above 105 GPa, which was generally consistent with the boundary of Pv-PPv transition reported by Murakami et al. [12]. The diffraction pattern of the recovered sample synthesized at 64.2 GPa and 1600 K indicates the coexistence of Pv and Mw as shown in Fig. 2.

TEM observations of the recovered samples indicated that the sample was amorphous, whereas some grains of segregated metallic iron were also observed in some of the samples, although the precise compositions of metallic iron were not determined due to its small grain sizes (less than 10 nm). No other phases were observed in the recovered samples. We determined the partition coefficients of Pv and Mw, and PPv and Mw based on the ATEM measurement.

Recent discovery of the post-perovskite (PPv) phase [12] revealed that this phase coexists with molten iron and some reactions between the phases may occur at the CMB condition. We have conducted a reaction experiment between molten iron and post-perovskite at 139 GPa and 3000 K equivalent to the CMB condition. The TEM image of the coexisting metallic iron and post-perovskite phase (Run 170En07) recovered from the CMB condition is shown in Fig. 4A, in which we can see a clear image of metallic iron sandwiched by PPv. Fig. 4B is the high magnification image of the same run product, where we can observe the metallic iron melt at triple junctions of the reaction image of the same run product, where we can observe the metallic iron melt at triple junctions of the reaction.

The compositions of the metallic iron and post-perovskite were determined by ATEM, indicating that a significant amount of oxygen up to 6.3 wt.% and silicon up to 4.0 wt.% are dissolved in metallic iron. Recent reevaluation of the outer core density revealed that it is lower by 7-10 % than that of pure metallic iron [23, 24]. The solubility of silicon and oxygen in molten iron observed in this study can readily account for density deficit of 10 % in the core. The present results strongly imply that both oxygen and silicon are the plausible candidates of the light elements in the core. The solubility of oxygen and silicon in molten iron coexisting with PPv and Pv increases with increasing pressure [23, 24]. The solubility of silicon and oxygen in molten iron observed in this study in CMB can produce the core signature of the plume source at the base of the lower mantle [36].

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Table 1  Experimental conditions and results

<table>
<thead>
<tr>
<th>Run no.</th>
<th>Pressure</th>
<th>Temperature</th>
<th>Duration</th>
<th>Phases observed</th>
<th>Xpv</th>
<th>Xmw</th>
<th>K</th>
</tr>
</thead>
<tbody>
<tr>
<td>SC4</td>
<td>32.2</td>
<td>1600</td>
<td>60</td>
<td>Mw+Pv</td>
<td>0.029(6)</td>
<td>0.186(11)</td>
<td>0.13(3)</td>
</tr>
<tr>
<td>SC8</td>
<td>41.5</td>
<td>1600</td>
<td>90</td>
<td>Mw+Pv</td>
<td>0.043(14)</td>
<td>0.216(3)</td>
<td>0.16(5)</td>
</tr>
<tr>
<td>SC22</td>
<td>58</td>
<td>1600</td>
<td>80</td>
<td>Mw+Pv</td>
<td>0.015(1)</td>
<td>0.147(13)</td>
<td>0.09(1)</td>
</tr>
<tr>
<td>SC14</td>
<td>95.4</td>
<td>1600</td>
<td>60</td>
<td>Mw+Pv</td>
<td>0.014(6)</td>
<td>0.102(19)</td>
<td>0.12(6)</td>
</tr>
<tr>
<td>SC15</td>
<td>123.6</td>
<td>1500</td>
<td>40</td>
<td>Mw+PPv</td>
<td>0.042(11)</td>
<td>0.129(24)</td>
<td>0.30(10)</td>
</tr>
</tbody>
</table>

Iron and post-perovskite reaction and solubility of O and Si in molten iron at CMB condition

<table>
<thead>
<tr>
<th></th>
<th>FeAd6</th>
<th>134</th>
<th>3500</th>
<th>60Fe(liquid)+K-fel(liquid)</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>FeEn19</td>
<td>130</td>
<td>2000</td>
<td>Fe(solid)+PPv</td>
</tr>
</tbody>
</table>

Potassium partitioning between iron and silicate and energetics of the core

<table>
<thead>
<tr>
<th></th>
<th>FeAd4</th>
<th>134</th>
<th>3500</th>
<th>SC15 123.6 GPa, 1500K T-quenched</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>FeAd6</td>
<td>104</td>
<td>3350</td>
<td>SC17 64.2 GPa, 1600 K Recovered</td>
</tr>
</tbody>
</table>

The partition coefficient of potassium between metallic iron and K-silicate, $K_{Fe-K}$, is estimated to be -3.88 and -3.49 log unit below the IW buffer for the experiments made at 134 GPa and 104 GPa, respectively.

The oxygen fugacity relative to the iron–wüstite (IW) buffer can be calculated on the basis of the activities of FeO in silicate and Fe in metal [43]. The oxygen fugacity was estimated to be -3.88 and -3.49 log unit below the IW buffer for the experiments made at 134 GPa and 104 GPa, respectively.

The partition coefficient of potassium between metallic iron and K-silicate, $D_K$, (= concentration, wt. %, of K in metallic iron / concentration, wt. %, of K in K-silicate), is $D_K \approx 0.15$ at 134 GPa and 3500 K. The $D_K$ value at 134 GPa and 3500 K is much larger than the
The partition coefficient determined up to 26 GPa in previous studies [38, 39, 42]. This suggests that pressure significantly affects the solubility of potassium in molten metallic iron. The increase in \( D \) with pressure is likely to be related to the change in electronic structure of potassium at high pressure [44, 45].

Our results indicate that potassium can readily be dissolved into the core by the chemical reactions between the molten iron and K-silicate at the CMB condition. The \( D \) value of 0.15 at 134 GPa and 3500 K, corresponding to the conditions of CMB, implies that the total potassium concentration in the core is about 35 ppm assuming that a primitive mantle concentration of potassium is 240 ppm [46]. The total potassium concentration of 35 ppm, or \( 4 \times 10^{-3} \) ppm \(^{40}\)K, in the core could produce 0.23 TW of radiogenic power, which corresponds to 2–12% of the current total heat flux across CMB, 2–10 TW [e.g., 47]. Our estimation is a tentative one because the \( D \) value could be modified by incorporation of sulfur into the core and its strong temperature dependency [e.g., 48].

Acknowledgement

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References

[4] Kondo, T., Ohtani, E., Hirao, N., Yagi,
Table 2 Chemical compositions of metallic iron and K-silicate determined by ATEM (values in weight %)

<table>
<thead>
<tr>
<th>Run</th>
<th>FeAd4 Metal at 134GPa and 3500K</th>
<th>FeAd6 Metal at 104GPa and 3350K</th>
</tr>
</thead>
<tbody>
<tr>
<td>n</td>
<td>134GPa and 3500K</td>
<td>104GPa and 3350K</td>
</tr>
<tr>
<td></td>
<td>Metal 7</td>
<td>K-fel 7</td>
</tr>
<tr>
<td></td>
<td>Fe</td>
<td>7</td>
</tr>
<tr>
<td>Al</td>
<td>0.16</td>
<td>0.05</td>
</tr>
<tr>
<td>Si</td>
<td>0.32</td>
<td>0.16</td>
</tr>
<tr>
<td>Fe</td>
<td>97.32</td>
<td>0.46</td>
</tr>
<tr>
<td>K</td>
<td>0.77</td>
<td>0.13</td>
</tr>
<tr>
<td>O</td>
<td>1.43</td>
<td>0.27</td>
</tr>
</tbody>
</table>

Partition coefficients of potassium, DK, between metallic iron and K-silicate are 0.15 ± 0.07 at 134 GPa and 3500 K and 0.016 ± 0.007 at 104 GPa and 3350 K, respectively. n: the number of area measured by ATEM.

Fig. 6 Typical EDS spectra of metallic iron (right) and K-silicate (left). (Insets) The spectra in the low energy range from 0 to 1.0 keV: O Kα line (E = 0.523keV), Fe Kα (0.615 keV), and Fe Kα (0.705keV).

K-silicate | Metallic iron
--- | ---


Method of Automatic Characterization of Inclusion Population by a SEM-FEG/EDS/Image Analysis System

Eric Hénault
CREAS – Research centre of ASCOMETAL

This text describes the system developed to automatically characterize the inclusions observed in polished surfaces of steel samples. A coupling was carried out between a field-emission scanning electron microscope (JEOL, JSM-6500F), an energy-dispersive spectrometer (EDS) (PGT, detector SDD SAHARA) and image analysis software (ADCIS, APHELION). The communication between these elements made it possible to develop software for inclusion measurement. The control functions allow automatic measurements over long periods according to various conditions of observation and analysis. It becomes possible to collect a very large amount of data thus enabling accurate statistical results to be obtained (thousands of analyzed inclusions per day in a clean steel sample). An example is given with improved machinability steels. The knowledge of the distributions and the characteristics of their various inclusion populations permit us to estimate the metal machining behavior.

Introduction

In 2001, ASCOMETAL research centre purchased a field-emission scanning electron microscope. In the list of requirements transmitted to the various suppliers of microscopes, we included the capacity of developing methods of inclusion characterization in an automatic way.

Indeed, until now, no microscope has made possible a complete control of the essential functions (displacement, magnification...) we need for our measurements. However, this demand is essential to obtain precise and statistically exploitable data.

If they are carried out in a manual way, these measurements are often too long and too tedious. For example, it is necessary to measure 300 inclusions to get results with an error lower than 10%, in the case of a homogeneous inclusion distribution. Nevertheless these results are essential for many studies about steels in order to know their properties or to improve the elaboration processes.

Thus, an apparatus running automatically 24 hours per day, and 7 days a week is required. To achieve this goal, JEOL (microscope), SYNERGIE 4 (EDS system, PGT) and ADCIS (image analysis system APHELION) have collaborated in the development of the control functions necessary for the application to inclusion characterization.

The expected functions, defined in the specifications, were added to the APHELION software as ActiveX components.

The application of inclusion characterization was then developed in VISUAL BASIC.NET based upon the APHELION ActiveX components.

The system (Figure 1) is more thoroughly described below. The next section is devoted to the benefits provided by the use of a scanning electron microscope compared to the use of an optical microscope. The second section introduces the list of the functions developed for the SEM-FEG/EDS/Image analysis system. Lastly, an example is provided to highlight one among the many possibilities of the system.

Description of the System

Advantages of a field-emission scanning electron microscope

The main limits of the inclusion characterization made by optical microscopy are:
- not very sensitive to the type of inclusion (the morphological criteria are often insufficient),
- the problems involved in the artifacts (dust, scar...),
- the problems involved in the poor depth of field.

Fig. 1 SEM-FEG/EDS/IA system.
From this non exhaustive list, the specifications of the ideal system for inclusion characterization are:
- signal stability to obtain comparable images,
- stage control to be able to scan a sufficient area in order to obtain statistically representative results,
- magnification control to obtain accurate inclusion sizes whatever the size of the inclusion,
- chemical contrast to discriminate the various inclusion phases,
- chemical composition to discriminate the various inclusion populations,
- resolution suited to detect inclusions smaller than a micrometer,
- improved depth of the field to maintain the image clarity.

We observe that the JEOL JSM-6500F field-emission scanning electron microscope provides these specifications. In particular, its beam can operate for hours without any signal variation. The accuracy of the motorized stage motion allows to detect and to observe the variation. The accuracy of the motorized stage provides these specifications. In particular, its beam can operate for hours without any signal variation.

The control functions of the field-emission scanning electron microscope

The general structure of the application is illustrated in Figure 2.

The equipment contains two PCs. One is dedicated to the control of the electron microscope. The second, on which SPIRIT software (analysis) and APHELION software (image analysis) are installed, controls the totality of the system. The inclusion characterization component is installed on this PC. The images acquired by SPIRIT are used in the application. The PCs and the various apparatus intercommunicate via Ethernet 100 Mbit/s connections.

Figure 3 illustrates in a simplified way the general structure of the application. It uses the functions of the microscope software, the analysis system (SPIRIT) and the ActiveX components of the image analysis software (APHELION).

The totality of the functions intervening in the application is listed in the following paragraphs a, b and c. The parameters manipulated by these functions are accessible in reading and writing.

a) Control functions of the JSM-6500F microscope:
- X, Y, Z axes movements,
- Rotation of the stage,
- Beam current value,
- Accelerating voltage,
- Magnification,
- Brightness,
- Contrast,
- Autofocus,
- Choice of the detector,
- Data backup of the initial conditions.

b) Control functions of the SPIRIT analyser:
- Positions (x,y) of the measured spectrum,
- Acquisition time of the spectrum,
- Acquisition mode of the spectrum,
- Data backup of the spectrum,
- Choice of the elements to be measured,
- Measurements on the selected elements,
- Automatic search of the elements on the spectrum,
- Size of an image (512, 1024, etc),
- Position and zoom factor,
- Time by pixel,
- Image mode,
- Number of frames to be added,
- Data backup of the image.

c) Image analysis functions:
- Measurement of grey levels values,
- Operators on the images,
- Possibility to use several images,
- Multiple thresholds,
- Morphological functions,
- Segmentations,
- Operators on the binary images,
- Measurements of the parameters.

These functions are necessary for the development of the general application of the characterization of inclusion populations.

General algorithm

The chain of the following principal actions constitutes the algorithm of the method.

Input data:
1 - Choice of the method,
2 - Identification of the samples,
3 - Positions of the samples on the stage,
4 - Positions of the zones of measurements,
5 - Method of focus,
6 - Method of scanning,
7 - Choices of the measurement options,
8 - Method of threshold,
9 - Criteria of chemical analysis,
10 - Backup files.

Measurements:
1 - Acquisition of an image,
2 - Image processing,
3 - Measurements of the parameters,
4 - Saving of the results.

Data processing:
1 - Treatment of the results,
2 - Final documents.

Performance of the system

The application allows to optimize the use of the electron microscope. Some studies require long analyses. They can last several tens of hours. They can be carried out without human intervention thanks to the system set up.

More than 100 inclusions are characterized per hour on a sample with a low inclusion density. Morphological and analytical measurements of each inclusion are saved in a results file. The data are then post-treated according to the nature of the results, adapted to the needs.

We distinguish measurements and treatments to allow multiple exploitations of the results files.

An example of application is proposed in the following paragraph.
Application: Characterization of VITAC 3000™ Steels

VITAC 3000™ steels are steel grades subjected to a specific treatment during casting. The goal is to obtain inclusions whose chemical nature, density, size and distribution improve the operations of machinability by limiting the wear on the tools. If one wishes to qualify castings, we can define a method of measurements adapted to the characterization of the various types of inclusions.

The various types included in these grades of steels are:
- lengthened sulphides,
- globular sulphides,
- oxides coated by a sulphide,
- oxides and sulphides joined,
- oxides.

The method must allow to distinguish precisely oxide and sulphide phases. It is also necessary to obtain data on the chemical nature of oxides and sulphides.

So, we define a method using the scanning electron microscope and its chemical analysis system. The sample is observed with a scanning magnification which makes it possible to detect and to measure inclusions larger than 3 micrometers in size (Figure 5). This magnification is chosen so that enough surface is observed in a reasonable time. In the method used, this magnification is equal to 430, which corresponds to 11 images per mm.

The defined threshold permits to segment the image. The sizes of the objects are measured on the binary image obtained.

The objects whose size is sufficient (small diameter larger than 3 micrometers) are analyzed, automatically (Figure 5). Under these conditions of observation, the measurement accuracy is not sufficient. So, each selected object is observed with a higher magnification.

This magnification of analysis is higher than 2000 (defined during the setting in data). The stage moves so that each selected inclusion is placed in the centre of the image acquired.

The morphological inclusion parameters and the various phase compositions are then measured. A threshold with two levels permits to isolate oxide and sulphide phases. If the inclusion width is larger than 3 micrometers (the greatest measurement accuracy allows to determine it), a chemical analysis of the different phases is made. The analysis time is equal to a few seconds. These measurements are made for each phase either in the geodetic center of the objects or by a scanning on the area.

Measurements are obtained from a sufficient area of the surface to reach the quality of results required from the statistical point of view.

The data file about inclusion parameters is then treated in an automatic way in order to determine the characteristic values of the various inclusion types. For examples, Figure 6 represents the histograms of the equivalent diameters of lengthened sulphides (type 1) and of globular sulphides (type 2). In Figure 7, one can observe the positions of inclusions which were detected on the observed surface.

Conclusions

The inclusion characterizations of steels are essential to classify the products or for the improvement of the processes of the steel plant.

When precise data about small size inclusion populations are expected, it is then necessary to analyze a significant area of a polished sample to attain a satisfactory precision in the results.

To achieve this goal, the automation of the scanning electron microscope coupled to an EDS (energy-dispersive spectrometer) system and a very complete software of measurements were developed. This software permits fast and precise measurements of a very significant number of inclusions considering the measurement conditions defined by the operator beforehand.

Indeed, having thorough input data makes it possible to describe all the methods that can be used in our domain. The automated application gives an optimal use of the microscope and its analysis system.
Direct Observation of Biomolecular Complexes by Cold-Spray Ionization Time-of-Flight Mass Spectrometry

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Introduction

Many biological processes are regulated by the specific and noncovalent intermolecular recognition between enzyme–substrate, antigen–antibody, receptor–ligand, carbohydrate–protein, and carbohydrate–carbohydrate. The direct observation of these biomolecular interactions is important for understanding the mechanisms behind these biological processes.

Electrospray ionization mass spectrometry (ESI MS) is an important tool for the investigation of noncovalent complex formation [1-6]. The advantages of MS over traditional methods such as UV/Vis spectroscopy, fluorescence spectroscopy, surface plasmon resonance (SPR), isothermal titration microcalorimetry (ITC), and nuclear magnetic resonance (NMR) spectroscopy include the accuracy of mass measurement, speed of analysis and small sample quantities. However, the harsh conditions of the ionization process in MS are often detrimental to the survival of noncovalent and unstable biomolecular interactions between sugar-protein, sugar-sugar and sugar-water complexes.

Recently, Yamaguchi and co-workers developed cold-spray ionization mass spectrometry (CSI MS) [7, 8] which does not require heat or an electric field and provides a snapshot of the state of compounds in solution. It is suggested that a cooled ion spray promotes stable solvation-ionization processes through increased compound polarizability by higher dielectric constants at low temperature. Using the CSI system, facile and precise characterization of labile self-assembling nanostructures and unstable organometallic complexes in solution was achieved [9, 10]. CSI MS may become one of the most promising and versatile tools for characterization of a variety of weak but specific biomolecular interactions, as ionization at a low temperature (–20°C) allows direct observation of unstable large-scale aggregates of amino acids or nucleosides in organic solvents with a magnetic-sector-equipped instrument [11-13]. Moreover, CSI MS combined with an orthogonal acceleration time-of-flight (oa-TOF) mass analyzer extends the applicability of this method to the characterization of the dynamic interactions of biomacromolecules. This is possible through a number of attractive features of TOF MS analyzers, such as their theoretically unlimited mass range, very high spectrum acquisition rates, high ion transmission, high sensitivity, multiplex detection capacity, reasonable mass resolution and simplicity in instrument design.

Our interest is focused on the potential of CSI-TOF MS, with particular attention to specific and weak biomolecular interactions in water at a low temperature. We have previously tried to monitor directly the formation of noncovalent protein-carbohydrate, carbohydrate-carbohydrate and carbohydrate-water complexes in an aqueous solution [14].

Carbohydrate-Protein Interaction

Among the biomolecular interactions involving carbohydrates, carbohydrate-protein interactions are well known and widely studied. For example, fertilization, cell adhesion, viral infections etc. are mediated by carbohydrate-protein interactions [15]. Thus a high-throughput and sensitive method to analyze carbohydrate-protein interactions contributes to the development of novel compounds (carbohydrates) and drug candidates that have a strong affinity for target proteins as well as promoting the deep understanding of basic biological functions.

We used the CSI-TOF MS to achieve high-throughput analysis of carbohydrate-protein interaction. The effect of temperature on complex formation between hen egg lysozyme and the chitooligosaccharide, chitotetraose is shown in Figure 1a. As anticipated, the intensity of the signal that corresponds to the lysozyme-chitotetraose complex was gradually enhanced by lowering the ion spray temperature of the reaction mixture from 200 to 4°C. It seems that the dissociation of carbohydrate-protein interaction was repressed. As shown in Figure 1b, CSI-TOF MS is quite an efficient and simple method for the determination of the dissociation constants of protein-ligand interactions, since it does not require the use of molecular probes. In fact, the $K_d$ of lysozyme with chitotetraose was determined to be $1.6 \times 10^{-5}$ M, which is in good agreement with data reported previously [16]. Furthermore, CSI-TOF MS can be used to search for a compound that shows the highest affinity for the target protein in a mixture of several oligosaccharides by making a simple “snapshot assay”. As illustrated in Figure 2a, lysozyme interacted selectively with chitooligosaccharides (GlcNAc)$_3$, (GlcNAc)$_4$ and (GlcNAc)$_5$ at 4°C in a compound library containing 23 different oligosaccharide types. Such valuable information could not be obtained by traditional ESI-TOF MS techniques carried out at 200°C as shown in Figure 2b. Moreover, when a compound library void of chitoigosaccharides was assayed at 4°C, lysozyme showed a significant affinity toward the maltooligosaccharides (D-glucose)$_3$, and $\gamma$-cyclodextrin (Figure 2c). These interactions cannot be detected by using general spectroscopic methods such as UV/Vis, fluorometric, and SPR. Figure 3a shows binding between lysozyme and maltotriose ((Glc)$_3$) $m/z$ 164.3, [M+9A]$^+$ and 1851.9, [M+8A]$^+$, “A” means ion adduct). Although the interaction is weak and is considered non-specific, the CSI data instead indicate specific binding. The results of a competition experiment (Figures 3a and 3b) suggest that maltotriose binding involves the same
**Fig. 1** Interaction of hen egg lysozyme with chitooligosaccharide.

a) Temperature dependency of the signal intensities of the lysozyme-chitotetraose (\((\text{GlcNAc})_4\)) complex in ESI (CSI) MS. Spray temperatures are indicated. \([\text{Lysozyme}]=35 \mu\text{M}, [\text{(GlcNAc)}_4]=200 \mu\text{M}\).

b) The binding of lysozyme with chitotetraose at 4°C. \([\text{Lysozyme}]=35 \mu\text{M}\). The (GlcNAc)_4 concentrations are indicated. The peak intensities from the mass spectra were used for the determination of the relative amount of bound lysozyme as a function of \([\text{(GlcNAc)}_4]\), and a sample Kd determination is shown at the bottom. GlcNAc = N-acetyl-D-glucosamine.

**Fig. 2** Carbohydrate-protein complex screening. The interaction of lysozyme with an oligosaccharide library containing GlcNAc, (GlcNAc)_2, (GlcNAc)_3, (GlcNAc)_4, (GlcNAc)_5, Glc, (Glc)_3, (Glc)_4, (Glc)_5, (Glc)_6, (Glc)_7, cellobiose (Glc\_\beta 1,4Glc), lactose (Gal\_\beta 1,4Glc), methyl a-mannoside, (Man)_5, D-glucosamine, L-arabinose, lacturose, xylose, L-gluconolactone, \(\alpha\)-CD, \(\beta\)-CD, and \(\gamma\)-CD (all 35 \mu M) was monitored by CSI-TOFMS at a) 4°C and b) ESI-TOF MS at 200°C. c) CSI-TOFMS analysis of lysozyme with an oligosaccharide library lacking chitooligosaccharides [(GlcNAc)_2, (GlcNAc)_3, (GlcNAc)_4, and (GlcNAc)_5] at 4°C. \([\text{Lysozyme}]=35 \mu\text{M}\).
carbohydrate-carbohydrate interaction might be a crucial step in cell-cell interaction that leads to cellular differentiation, cell growth, and malignant alterations [17]. Lewis x trisaccharide (Le\(^x\)) has been reported to form a self-assembly through carbohydrate-carbohydrate interaction in the presence of Ca\(^{2+}\) ions involving the adhesion of blastomeres. We demonstrated the direct observation of carbohydrate-carbohydrate interaction of Le\(^x\) trisaccharide by using CSI-TOF MS. As shown in Figure 4, CSI-TOFMS spectra measured at 4°C clearly demonstrate that Le\(^x\) trisaccharides

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lysozyme cavity as for chitotriose (GlcNAc\(_3\)). This is supported by computer-assisted docking simulations carried out in our laboratory (Figure 3c). Notably, CSI-TOFMS can be employed to search for unexpected ligand candidates with “specific and low affinity” for a target protein. Identified ligands could then be applied as scaffold molecules for designing new drugs (inhibitors) with a high potential for success. **Carbohydrate-Carbohydrate Interaction**

Carbohydrate-carbohydrate interaction might be a crucial step in cell-cell interaction that leads to cellular differentiation, cell growth, and malignant alterations [17]. Lewis x trisaccharide (Le\(^x\)) has been reported to form a self-assembly through carbohydrate-carbohydrate interaction in the presence of Ca\(^{2+}\) ions involving the adhesion of blastomeres. We demonstrated the direct observation of carbohydrate-carbohydrate interaction of Le\(^x\) trisaccharide by using CSI-TOF MS. As shown in Figure 4, CSI-TOFMS spectra measured at 4°C clearly demonstrate that Le\(^x\) trisaccharides
preferentially dimerize by binding to Ca\(^{2+}\) ions, and that in the absence of Ca\(^{2+}\), Le\(^{x}\) trisaccharides form a range of large aggregates of up to 10 trisaccharide units \(m/z 2670.0, [10\text{Le}^{x} + 2\text{Na}]^{2+}\) (Figure 4b). Several ion peaks shown in Figure 4a are evidence for the preferential \(\text{Le}^{x} \cdot \text{Ca}^{2+}\) complex formation such as \([\text{Le}^{x} + \text{Ca} – \text{H}]^{+}\), \([\text{Le}^{x} + \text{Ca} – \text{H} + \text{H}_{2}\text{O}]^{+}\), and \([\text{Le}^{x} + \text{CaCl}]^{-}\). The ion peaks of \([2\text{Le}^{x} + \text{Ca}]^{2+}\), \([2\text{Le}^{x} + 2\text{Ca} – 2\text{H} + 2\text{H}_{2}\text{O}]^{+}\), and \([2\text{Le}^{x} + 2\text{CaCl}]^{-}\) provide valuable information that reveals the mechanism of \(\text{Le}^{x} \cdot \text{Le}^{x}\) dimerization in the presence of Ca\(^{2+}\) ions. The use of CSI-TOF MS is key to elucidating the mechanism of carbohydrate-carbohydrate interaction.

**Glycoprotein-Water Interaction**

Anti freeze glycoprotein (AFGP) is a tandem repeating glycopeptide exhibiting an inhibition effect on the ice crystal growth. Monomeric \(\text{syAFGP}\) does not have antifreeze activity and the minimal active structure of the antifreeze glycopeptide was found to be \(\text{syAFGP}\) with three repeats [18]. We thought that the interaction between AFGP and water molecules may be related to the antifreeze activity of AFGP, and tried direct observation of AFGP-water complexes by using CSI-TOF MS (Figure 5). It appears that the active \(\text{syAFGP}\) forms specific complexes with three water molecules, whereas the inactive monomeric \(\text{syAFGP}\) produced neither the complex with water nor the self-aggregation found in the \(\text{Le}^{x}\) trisaccharide. Hydration of \(\text{syAFGP}\) at 4°C observed as \(m/z 949.4 [M + 3\text{H}_{2}\text{O} + 2\text{H}]^{2+}\), \(m/z 960.4 [M + 3\text{H}_{2}\text{O} + \text{H} + \text{Na}]^{2+}\), and \(m/z 968.4 [M + 3\text{H}_{2}\text{O} + \text{H} + \text{K}]^{2+}\) by CSI-TOFMS may become an important way to investigate AFGP binding with the ice (water) lattice, and hence the mechanism of its antifreeze. As indicated in Figure 5 (c), when fully deuterated \(\text{syAFGP}\) with D\(_{2}\text{O}\) as the solvent was observed, an analogous spectrum with the “water signals” shifted by 20 Da instead of 18 Da was obtained. This is evidence that the binding of three water molecules is favored over the binding of just one or two.

**Mechanism of Dynamic Inhibitor for Glycosyltransferase**

Glycosylation conducted by glycosyltransferases is one of the crucial biological processes for the post-translational modifications of proteins and lipids. Selective inhibitors of glycosyltransferases are therefore of interest because they may lead to the development of novel and potential therapeutic reagents. The
complex and dynamic reaction mechanism of glycosyltransferases involves many components such as a sugar nucleotide as a donor substrate, an acceptor sugar substrate, and a metal ion [19]. We had synthesized a novel dynamic inhibitor for β1,4-galactosyltransferase and analyzed the inhibition mechanism using CSI-TOF MS [20]. Inhibitor 1 was designed and synthesized based on the crystal structure of bovine β1,4-galactosyltransferase (β-GalT1). It is known that β-GalT1 undergoes critical conformational changes upon glycosyl donor substrate binding. First, tryptophan 314 located in the small flexible loop near the active site moves toward the catalytic pocket to interact with the complex of the donor substrate and Mn²⁺ ion. This movement leads to conformational changes in the enzyme, which are essential for the subsequent acceptor-substrate binding. We hypothesized that the naphthalene group linked to the galactose residue of inhibitor 1 strongly binds to the tryptophan 314 to stop the conformational change of the enzyme, resulting in the inhibition of the acceptor-substrate binding. The inhibitory activity of 1 was determined by HPLC analysis, Ki = 1.86 µM. If the hypothesis that inhibitor 1 stops the conformational change of the enzyme is correct, the βGalT1-inhibitor 1 complex does not show any binding capacity with the acceptor sugar substrate. We verified this by direct observation of the enzyme-substrate complex using CSI-TOF MS (Figure 6). The complex of βGalT1 with UDP-Gal and Mn²⁺ (m/z 3044.1) shifted to the peak at m/z 3030.10 due to GalT1-UDP-Mn²⁺ and to the peak at m/z 3073.1 corresponding to the molecular mass for the complex of GalT1-UDP-Mn²⁺-acceptor substrate 2. On the other hand, the complex of βGalT1 with inhibitor 1 and Mn²⁺ (m/z 3066.6) exhibited no binding capacity toward an acceptor substrate 2.

These results agree with our hypothesis that inhibitor 1 prevents the binding of the acceptor substrate with βGalT1 and this is the first demonstration of the observation of enzyme mechanism without any probe molecule.

**Summary**

We found that CSI-TOF mass spectrometry is a highly sensitive and reliable method for analyzing specific non-covalent complexes of glycoconjugates under non-disruptive conditions. The results reported herein demonstrated the ability and versatility of CSI-TOFMS for the direct monitoring and characterization of weak and specific carbohydrate-related interactions in an aqueous solution at low temperature. This novel technique provides us not only with the basic insights into the mechanism of biomolecular recognition, but also with valuable information for high throughput molecular searching for bioactive key compounds for the discovery of new drugs.

**References**


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**Fig. 6** Evidence of competitive inhibition by inhibitor 1 in the dynamic conformational change of β-GalT1 detected by CSI-TOF MS at 37°C. (A) Structure of inhibitor 1 and acceptor substrate 2. (B) a) Ion peak at m/z 2991.7 shows [M+2H]²⁺ of βGalT1 (95 pmol). b) Spectrum of βGalT1 (95 pmol) in the presence of acceptor substrate 2 (450 pmol). c) Spectrum of βGalT1 (95 pmol) in the presence of UDP-Gal (400 pmol). A significant signal corresponding to the βGalT1-Mn²⁺-UDP-Gal complex was observed at m/z 3044.1. d) A typical spectrum of βGalT1 (95 pmol) obtained in the presence of both UDP-Gal (40 pmol) and acceptor substrate 2 (450 pmol). The ion peaks due to βGalT1-Mn²⁺-UDP (m/z 3030.1) and the complex of βGalT1-Mn²⁺-UDP-acceptor substrate 2 (m/z 3073.1) were observed. e) A spectrum of βGalT1 (95 pmol) in the presence of excess amount of acceptor substrate. Acceptor substrate 2 (450 pmol) was added to the complexes formed in an experiment d). The signal intensity, due to the complex of βGalT1-Mn²⁺-UDP-acceptor substrate 2, was drastically enhanced. f) The spectrum of βGalT1 (95 pmol) in the presence of inhibitor 1 (400 pmol). A significant signal corresponding to the complex of βGalT1-Mn²⁺-inhibitor 1 (m/z 3066.6) was observed. g) The effect of the addition of an acceptor 2 (450 pmol) to the complex of βGalT1-Mn²⁺-inhibitor 1.
Methods of Evaluating Activity of Photocatalytic Materials Using Electron Spin Resonance (ESR) Spectroscopy

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Introduction

TiO₂, known as a photocatalyst, was conventionally used as a white pigment for various applications. At the end of 1960s, Fujishima, Honda and co-workers discovered that when a photoelectrode reaction is performed using TiO₂, water is decomposed by an electrolysis [1, 2]. Since this discovery, new applications of TiO₂ emerged. One is a new energy supply technique which decomposes water using the solar-light energy and then converts it into the H₂ energy. Another is to decompose harmful organic substances using light, as an environment-purification material. As the awareness of ecology is increasing worldwide, photocatalysts have been attracting interest as energy-free environment-conservation materials. At present, a variety of products contain photocatalysts in the fields of water purification, decomposition of bad-odor gas and sick-house gas, removal of soil contaminants, and measures for anti-bacteria and anti-molds. Furthermore, in the future, photocatalysts are expected to extend their usage to medical care and electronics. The market for these fields reaches about 30 billion yen (as of 2004) and also, there is a prediction that this market will exceed 100 billion yen in a few years.

Features of TiO₂

TiO₂ is a white microcrystal with high melting point. This is a chemically stable substance that dissolves only in hot concentrated sulfuric acid. In addition, TiO₂ is a semiconductor with a relatively high band gap and features a high refractive index. TiO₂ possesses three crystalline forms: rutile, anatase and brookite. Since brookite is unstable, rutile and anatase are widely used for industrial use. The band-gap energy of anatase is 3.2 eV and that of rutile is 3.0 eV.

As the environmental-pollution problem is becoming increasingly serious, society now demands the development and application of environment-purification materials. In order to achieve this mission, a number of national research laboratories and private industries are pursuing research on these materials. Titanium dioxide (TiO₂), a typical photocatalytic material, is applied to various products as an energy-free environment-purification material. In this paper, the author introduces the progress of the method of evaluating its photocatalytic functions.

A photocatalyst produces a free radical by irradiation, and this radical decomposes harmful substances. This reaction is applied to boards for micro-printing on electronic devices as well; therefore, TiO₂ is a useful industrial material that can be utilized for a wide range of applications. However, the evaluation of its performance is said to provide an insufficient accuracy, because the evaluation is carried out by actually measuring the oxidation rate of specific substances, such as methylene blue (MB) and nitric oxide (NO), with a long measurement time.

The Electron Spin Resonance (ESR) spectrometer is the only instrument enabling one to directly observe a free radical which is the main source of oxidation. The principle of ESR is suitable for the evaluation of photocatalysts; however, previously, there were several problems with the measurements. Recent technological advancements in ESR have solved these problems, making it possible to carry out practical evaluations. That is, using ESR, one can directly quantify radical production that is an essential part of the photocatalytic mechanism. Taking advantage of this scheme, the evaluation of photocatalysts for very thin films, whose demands are expected to increase in the future, can be performed more accurately and speedily than with conventional evaluation techniques. In this paper, the author presents several examples of evaluations. By applying ESR, the development of various photocatalytic materials such as TiO₂ is expected to advance.

JES-FA200 Electron Spin Resonance Spectrometer
rutile is 3.0 eV (3.2 eV for brookite). These band-gap energies correspond to the light energy of the ultraviolet (UV) range. This indicates that TiO₂ absorbs UV and enters a high-energy state, then it possesses a photocatalytic activity. Because anatase has higher band-gap energy, it is thought to be more active than rutile as a photocatalyst. This results in the fact that anatase is used mainly as a photocatalyst, whereas rutile is used in other industrial products.

**Mechanism of Photocatalyst**

The catalytic mechanism of photocatalyst (TiO₂) is thought to derive from the free radicals produced by TiO₂. This mechanism is illustrated in **Fig. 1**. When TiO₂ is irradiated with UV, a hole and an electron are generated. They react with water and oxygen in the environment, producing hydroxyl radical (HO⁻) and superoxide anion radical (O₂⁻) respectively. Since HO⁻ is a highly reactive free radical, it oxidizes and decomposes surrounding organic materials. O₂⁻ itself is less reactive, but it reacts with water in the environment and generates hydrogen peroxide (H₂O₂). Then, H₂O₂ is decomposed by UV to produce HO⁻. This HO⁻ also has the decomposition activity as HO⁺ generated by the hall does. Based on these processes, if the HO⁺ production is quantified, one can acquire the decomposition activity of TiO₂ products. This is the reason why ESR is thought to be suitable for the evaluation of photocatalytic activity.

**Methods of Evaluating Photocatalytic Activity**

Methods of evaluating the photocatalytic activity of TiO₂ are compared between the conventional and ESR methods, as follows.

**Conventional evaluation methods**

Two typical methods of evaluating photocatalysts, the MB decomposition method and the NO removal method, are presented in **Figs. 2 and 3**. The former method is applied in an aqueous solution, whereas the latter method is used in the air. Both of these methods utilize
the contact of specific substances to react them and measure the amount of change due to their reaction. They seem to be appropriately used depending on photocatalyst products.

In the MB method (Fig. 2), an acrylic cylinder or a polyethylene cylinder is mounted on a test piece, then a MB solution is introduced into the cylinder and the decomposition rate is measured. As a pre-treatment, MB adsorption is conducted for about twelve hours. Next, a new MB test solution is introduced again into the cylinder. Irradiation to the MB test solution is continued for three hours while part of the MB test solution is taken out and measured.

The NO removal method, which evaluates catalytic activity using ESR, is normally generated and HO• formed by magnetic-field modulation and phase detection. Thus, the central horizontal axis is taken as the base line, providing signals upward and downward. For the quantification of DMPO-OH, the signal intensity of either one line is measured. Typical ESR measurement conditions are as follows: Microwave frequency: 9.42 GHz, Microwave power: 4 mW, Magnetic field: 335.3 ± 5 mT, Modulation width: 100 kHz - 0.2 mT, Sweep time: 4 min, Time constant: 0.3 s, Instrument: JES-FA200.

Methods of evaluating photocatalytic activity using ESR

The conventional methods mentioned in the previous section measure reactions where specific substances are decomposed by HO• generated from photocatalysts. Since the photocatalytic activity is based on HO• generated by irradiation, the decomposition activity of materials depends on the HO• generation ability of TiO2. Accordingly, evaluation of photocatalytic functions by the measurement of HO• production may be a more direct technique. ESR can selectively measure radicals and provide good reproducibility due to its high sensitivity; therefore, it is possible to perform faster and more efficient evaluation than with conventional methods.

However, HO• is highly reactive and its lifetime is very short, so direct measurement of HO• is difficult even with ESR. For this reason, an adduct (DMPO-OH) with a spin-trap reagent 5,5-dimethyl-1-pyrroline-N-oxide (DMPO) is normally generated and HO• measurement is performed. The reaction between DMPO and HO• is quickly conducted for routine measurement of photocatalytic activity. This has made it possible for ESR to perform highly reliable measurement. In addition, from the ESR instrumental viewpoint, automated tuning and high-sensitivity capability have allowed ESR to offer sufficient functions for routine measurement of photocatalytic activity.
A DMPO solution is introduced into a ring and it is irradiated. The inner liquid is taken out and measured.

The principle of this method is similar to the conventional MB method. A cylinder is made of quartz glass (quartz ring), instead of polyethylene for the MB method. An edge of this quartz ring is coated with silicon grease and fixed on the sample surface. A 1 to 1.5 mL of DMPO solution is introduced into the ring and a quartz plate cover is mounted on the ring, then irradiation is conducted for the ring. After a certain time of the irradiation, the inner liquid is taken out and measured.

**Examples of Evaluation of Photocatalytic Activity Using ESR**

Next, we present examples of evaluation of radicals in actual samples, using ESR. Here, samples subjected to evaluation are 1) an air-cleaning sheet that is widely used as an environment-purification product, and 2) a patterning board for micro-printing that is prevailing in the electronics field.

**Evaluation of an air-cleaning sheet photocatalyst**

A thin film, which holds an extremely small amount of TiO₂ (50 µg/m²) on a resin film, was evaluated by the tissue cell method (Fig. 5 (b)). Three samples from this thin film were subjected to measurement. The two samples (No. 1 and 2) were produced by different techniques and their product performances were known. The third sample (No. 3) was a blank sheet. The respective cells containing the three samples were inserted into the ESR instrument and measured three times: 1) before irradiation, a thin film, which holds an extremely small amount of TiO₂ (50 µg/m²) on a resin film, was evaluated by the tissue cell method (Fig. 5 (b)). Three samples from this thin film were subjected to measurement. The two samples (No. 1 and 2) were produced by different techniques and their product performances were known. The third sample (No. 3) was a blank sheet. The respective cells containing the three samples were inserted into the ESR instrument and measured three times: 1) before irradiation, 2) after irradiation for 10 minutes, and 3) after irradiation for 20 minutes.

**This method uses a tissue cell, in order to originally measure radicals produced from a thin tissue of animal organs. The tissue cell method is suitable for a sample that floats on a DMPO aqueous solution when the immersion method is applied. A sample is cut into a rectangle approximately 4 mm x 35 mm squares and placed in a tissue cell in such a way that the coated surface of photocatalyst faces upward. A 60 to 80 µL of DMPO solution is dropped onto the coated film, then the tissue cell is shielded with a cover glass around which coating of silicon grease is applied. Irradiation is started and after a certain time of the irradiation, this cell can be directly inserted into an ESR instrument for measurement.**

In these three photocatalyst evaluation methods by ESR introduced here, an irradiation time is twenty minutes at longest. Compared to the conventional MB method, in which a sample reacts in an aqueous solution as in these three methods, the three ESR methods can provide extremely fast evaluation of photocatalytic properties, and also are suitable for screening analysis. Thus, the immersion, tissue cell, and ring methods are expected to achieve fast data feedback in the development and improvement of photocatalyst products.

**Figures 5 (a) to (c) show the measurement systems of photocatalysts using ESR developed until now. All of methods make a sample contact with a DMPO aqueous solution, and measure the DMPO-OH signal intensities after a certain time. In the immersion method (Fig. 5 (a)) and the ring method (Fig. 5 (c)), a 200 µL of a DMPO aqueous solution is taken out and it is transferred to a dedicated aqueous solution cell for measurement. In the tissue cell method (Fig. 5 (b)), a photocatalyst sample is placed in a cell and irradiated, then it is directly measured by ESR. Depending on sample and purpose of measurement, an appropriate system is selected.**

The immersion method is a most traditional evaluation method. In this method, a DMPO aqueous solution is introduced into a plate, and a sample is cut if necessary, then it is immersed. This technique can be applied to photocatalyst products with various shapes. The tissue cell method is suitable for thin-film samples that can be easily cut. Since the cell for ESR measurement is made of synthetic quartz and has high UV transmissivity, it is possible to irradiate a sample through the cell from the light situated above this cell. Also, after a certain time of the irradiation, this cell can be directly inserted into an ESR instrument for measurement.

The ring method is suitable for planar samples. In particular, this technique is most fitted to samples that are difficult to cut, such as hard glass plates and metal plates. In these three photocatalyst evaluation methods by ESR introduced here, an irradiation time is twenty minutes at longest. Compared to the conventional MB method, in which a sample reacts in an aqueous solution as in these three methods, the three ESR methods can provide extremely fast evaluation of photocatalytic properties, and also are suitable for screening analysis. Thus, the immersion, tissue cell, and ring methods are expected to achieve fast data feedback in the development and improvement of photocatalyst products.
tion, 2) when the irradiation is temporarily stopped after 7.5 min, 3) when the irradiation is temporarily stopped after 15 min. Figure 6 shows three ESR spectra for the case 3) (after 15-minute irradiation).

The three samples were cut into three pieces respectively and each piece was measured. Signal intensities of stars and Mn marker signal intensities in the figure were obtained and analyzed. Deviation is c.v. ± 7%, indicating that the HO· generation ability from each sample significantly differs from each other. This result showed a good correlation with the product performance already confirmed, demonstrating that ESR is a highly reliable evaluation method.

Figure 7 shows irradiation-time dependency of the DMPO-OH relative intensity. As is found from Fig. 7, the intensity difference between No. 1 and No. 2 is clearly visible from the beginning of the irradiation. From this result, it is demonstrated that ESR can rapidly evaluate an air-cleaning sheet photocatalyst in the prior step of its production, which is one of environment-purification products.

Evaluation of photocatalytic films for micro-printing

When a mold (pattern) that prints 10 μm fine-patterns on an electronic device is created, the decomposition mechanism of a photocatalyst is utilized. The evaluation of photocatalytic films (photocatalyst patterning board) used for creating the patterns [5, 6] was performed using ESR. The samples used for measurement were three types of TiO2 films (No. 1, No. 2 and No. 3, film thickness of each sample = 100 nm). The TiO2 dispersion liquid for No. 1 is different from that for No. 2 and No. 3. Whereas, No. 2 differs from No. 3 in a film-formation technique. Because the patterning board of each sample is made of glass, evaluation was performed by the ring method (Fig. 5 (c)). In addition, a blank sample that was not deposited by TiO2 was measured.

Furthermore, as the purpose of comparison, the contact-angle measurement method (Fig. 8) was conducted for the four samples (No. 1 to 3, and blank). This method measures the contact angle between a photocatalytic thin film and a drop of water after irradiation, in order to evaluate the decomposition activity in organic substances induced by a photocatalyst. Since these film samples are very thin, when the conventional MB method was used, the amount of MB decomposition was very small and the obtained data was equivalent to the detection limit of the detector. Thus, an evaluation system employing the contact-angle measurement method was established [5, 6]. In this method, a TiO2 film is coated with hydrophobic organic molecules and a drop of water is placed on this film, then the film is irradiated. TiO2 is excited by light to generate radicals, decomposing the hydrophobic film.

As a result, a drop of water becomes flat, directly contacting with the TiO2 film. At this time, the contact angle between the film and the water drastically decreases. This decreased angle is used as a value for the photocatalytic activity.

Figure 9 (a) and (b) are the results of measurements. Figure 9 (a) shows the result obtained by ESR measurement and (b) shows the result obtained with the contact-angle measurement method. As is found from these results, in the photocatalytic activity evaluation by ESR, the order of activity was No. 2 > No. 1 > No. 3 and No. 3 showed almost no activity. In contrast, the order obtained by the contact-angle method was No. 2 > No. 1 > No. 3. The performance test data obtained from the final product was No. 2 > No. 1 > No. 3, equivalent to that obtained with ESR. Thus, as shown in Table 1, the product performance agreed well with the evaluation result obtained by ESR, indicating that the ESR method accurately reflects the photocatalytic activity of the photocatalytic thin film.

As presented above, it became clear that, compared to the contact-angle measurement method, the ESR method can perform accurate evaluation of photocatalytic activity. Also, it was demonstrated that, even when a photocatalyst product is in the material stage prior to its production, it could be rapidly evaluated with a high precision using ESR. In particular, the great advantage of ESR is that this method can
accurately evaluate samples with low reactivity, for example, very-thin photocatalytic films used in our present experiments. With the conventional MB method, these samples could not be evaluated.

It is known that the photocatalytic activity of photocatalyst products are different depending on their production techniques, even when the raw materials of anatase is used for these products. As recognized in the above experiments, ESR is an effective method since it provides higher accuracy than offered by other conventional methods which cannot distinguish the difference in the photocatalytic activity.

In addition, generally, the conventional methods evaluate the catalytic activity using the decomposition activity of one specific substance; therefore, the activity obtained by these methods holds only for limited substances. However, many contaminants in the water or air are mixtures of various substances. The great advantage of ESR is to directly measure the HO\(^\bullet\) generation ability which is the origin of oxidizing and decomposing any substances. Thus, ESR is thought to be an efficient measurement method, since ESR can evaluate potential catalytic functions of photocatalysts and provide more reliable catalytic information than other methods.

**Conclusion**

The TiO\(_2\) catalyst is a technological product developed in Japan, and it is expected to further prevail worldwide. Now, the developments of visible ray responsive photocatalysts [7] and photocatalysts employing metals except for Ti are aggressively implemented. In view of the expansion of the photocatalyst market, in March 2006, Photocatalysis Industry Association of Japan was established in association with many organizations such as the Japan Association of Photocatalyst Products. Also, the establishment of JIS for various photocatalytic evaluation is being under development. It is concluded that photocatalytic-activity evaluation using ESR will become a very useful method for efficient development of new photocatalyst products and for further development of the photocatalyst market.

Note: Patents on the ESR standard for pattern evaluation layers were jointly applied by Dai Nippon Printing and JEOL [8].

**Acknowledgement**

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**References**

[8] Patents pending.
Auger Analysis of Cross Sections Prepared by Cross Section Polisher

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Introduction

Auger Electron Spectroscopy (AES) provides a high spatial resolution (10 to 20 nm) and can analyze nanometer-level regions from the top surface to a depth of 6 nm; therefore, AES is used for particle analysis and structural analysis of top surfaces of specimens. Also, it is applied to fine structure analysis of cross sectional samples.

However, analysis results of cross sections depend greatly on the quality of the prepared specimens. For example, if distortion or altered layers due to milling exist on a specimen surface, Ar sputtering to remove them is needed before Auger analysis. A long-time Ar sputtering increases the effects of surface roughness and preferential sputtering, making precise cross-sectional structure analysis difficult. Furthermore, to analyze cross-sectional fine structures of a shallow region near the top surface, cross sections are prepared by FIB (Focused Ion Beam). However, FIB is limited to preparing a shallow region of cross sections, a few tens of micrometers in depth from the surface and a few tens of micrometers in width. Thus, cross-section specimens that can be prepared for Auger analysis are limited.

JEOL has developed the Cross Section Polisher (CP). This cross-section specimen preparation device can easily prepare a cross section that has a few hundreds of micrometers in width and can preserve nanometer-level fine structures. CP prepares a cross section in the following way: A high-energy Ar ion beam irradiates the surface of the specimen masked by a shielding plate, from the direction perpendicular to the surface. Thus, the surface region which is not masked by the shielding plate is etched. This device provides two advantages: a) A clean cross section can be obtained, which has less distortion or altered layers due to milling than prepared by conventional mechanical polishing methods, b) A wide-region cross section can be prepared as compared to FIB. Utilizing these advantages, CP has been used as a powerful cross-section preparation tool for SEM, EPMA, and AES.

This paper briefly explains the principle and applications of CP, and focuses on the points which require care in AES, then introduces application examples of cross-section Auger analysis.

Cross Section Preparation by CP

Effectiveness of CP compared to conventional polishing methods

For cross-section preparation, the mechanical polishing method, which cuts a specimen and completes polishing by using grinding wheels and abrasives, is widely used. This method polishes a specimen by utilizing physical contact between the abrasive and the milled surface. Since the portions protruding from an uneven surface are milled selectively, it is easy to prepare some materials (specimens) into flat mirror-surfaces. Furthermore, a wide selection of grinding wheels and abrasives for various structures allows the control of the milling time and the roughness of the milled surface, and many efficient mechanical polishing devices have been developed. Thus, this is a very effective method. However, mechanical polishing may preserve the affected layers on the polished surface and make it not clear the real interface due to the phenomenon of hard materials being covered with soft materials (called distortion due to polishing). Therefore, the quality of the polished surface largely depends on the skill of the operator, and the point is a disadvantage.

In order for anyone to easily prepare clean cross-section specimens without special skill, CP was developed. The appearance of this device is shown in Fig. 1. The main features of CP are as follows:

- CP can prepare a wide range of materials into flat mirror surfaces: a) Soft materials, such as copper, aluminum, gold, solder and polymer, which were difficult to prepare into flat mirror surfaces by conventional mechanical polishing, b) Hard materials, such as ceramics and glasses that are difficult to cut, c) Materials with different hardness levels.
- CP can preserve fine structures of cross sections, such as voids in the bonded interface between gold wires and aluminum pads, which otherwise are crushed by conventional mechanical polishing. This feature also enables one to check how strong the adhesion between plated layers and those of solvents are.
- CP can polish wider areas than FIB can.
- Mechanical polishing requires special skill for some materials, but for polishing with CP, an operator can acquire skill in a relatively short time, making it easy to prepare a clean cross section.

For these reasons, CP is very useful for pre-treatment before cross sectional analysis with SEM, EPMA and AES. The next section briefly describes the principle and the method of milling with CP.

Principle of milling with CP

Figure 2 shows the principle of milling with CP. First, as a pre-treatment, a preliminary cross section is prepared by cutting or mechanical polishing in such a way that this section has a trimmed portion necessary for CP milling, having a thickness of 30 to 75 µm. Next, the surface of this section is covered with a shielding plate with the trimmed portion protruding beyond the edge of the shielding plate, and the section is placed on the motor-driven eccentric stage. Then, the milling time is set by a timer and this section is irradiated with a 2 to 6 keV Ar ion beam for preparing the target cross section just beneath the shielding plate.

Figure 3 shows an example of a cross section milled by CP. As shown in the figure, a half-moon shaped cross section is formed. The width and depth of the milled surface depend on the energy of the Ar ions and the irradiating time. In general, the Ar ion energy is determined by the properties of the milled specimen and the Ar ion irradiation area, whereas the irradiating time is determined by the depth and volume of the milled section.

Procedure for cross section preparation

Since the milling process with CP is automated, it is easy to prepare cross sections through unattended operation. However, actually, pre-treatment prior to CP milling is a key point. This requires cutting or polishing, and resin coating to protect the surface of specimen. The procedure for cross-section preparation with CP including the pre-treatment...
before CP milling is as follows (Fig. 4).

1) Select a specimen to be milled with CP.

2) Process the specimen until its size becomes appropriate for CP milling.

First, it is necessary to process the specimen to an appropriate size which the CP can accommodate. This size is 11 mm (width) × 10 mm (length) × 2 mm (thickness) or less. To obtain this size, the specimen is adjusted by cutting, slicing or polishing. In this process, it is necessary to protect the surface of the specimen. If necessary, it is better to carry out step 3 – resin-coating the surface – in advance. As mentioned earlier, since a trimmed portion with an edge distance of 30 to 75 μm from the target is needed to be prepared into a cross section, care should also be exercised in this step.

3) Resin coating to protect the surface

Since CP irradiates the specimen surface with Ar ions from the vertical direction, the top surface of the specimen is directly etched, altering its original morphology. Also, as shown in Fig. 5, even when the top surface is uneven, etching (milling) goes on over the entire surface with its altered morphology preserved. As a result, vertical streaks due to the unevenness appear on the milled cross section. To reduce these effects, it is necessary to carry out pre-treatment, which coats the specimen surface with resin and hardens it on glass for preparing a flat-surface specimen.

4) Cross sectional milling with CP

When steps 1 to 3 are completed, it is time to automatically prepare a cross section with CP.

Specimens appropriate for CP

Generally, in etching with Ar ions, it should be noted the following two points: a) the etching rate is different depending on the properties of materials (for a material with the same properties, the etching rate is the same), b) even when etching is applied to a material with the same property, if the material has an alloy phase, preferential sputtering arises and a phase different from that in the bulk state appears on the surface, causing surface roughness to occur.

Preferential sputtering is a phenomenon that...
It is more detected from a region (with-
section). In conclusion, from the Auger spectra
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are appropriate for CP milling and some speci-
cial mechanical polishing is applied prior to
form efficient CP milling, it is necessary to
arise, degrading the advantage of CP. To per-
face analysis. To prevent this in cross-sectional
sections can be obtained using Auger analysis.
was irradiated with a 10 kV, 40 nA electron
beam, the peak intensity of C does not
crease, decreasing the peak intensity of O.
from the cross section, or if any layer covers another layer on
In summary, CP is a useful tool for prepar-
ing cross sections; however, some specimens
occur when Ar ion etching is applied to the
surface of an alloy phase comprised of two or
more elements. A specific element is preferen-
tially sputtered and the atomic concentration of
the surface becomes different from that in the
bulk state. For example, for InP, since P is
sputtered faster than In due to preferential
sputtering, surface roughness occurs and the
atomic concentration ratio between In and P of
the top surface is different from that in the
bulk state [1], [2]. To reduce the effect of pref-
erential sputtering, it was reported that
decreasing the incidence angle to the surface is
a good solution [3], [4]. In CP, Ar ions irradi-
ate the surface of the cross section in parallel,
drastically reducing the preferential sputtering
effect even for a material containing various
elements, and preparing a flat cross section.
However, in CP, milling to remove a
trimmed portion is performed prior to milling
for cross-section preparation, as mentioned
before. In this process, Ar ions irradiate the
specimen surface from the vertical direction.
This means that preferential sputtering may
arise, degrading the advantage of CP. To per-
form efficient CP milling, it is necessary to
prepare the trimmed portion as small as possi-
ble.
For a specimen susceptible to heat, some-
times a long-time CP milling is required since
the accelerating voltage and the Ar ion beam
current are kept low. Depending on the pur-
pose of the analysis, only cutting or conven-
tional mechanical polishing is applied prior to
CP milling for cross-section preparation.

**Auger Analysis of Cross Sections Prepared by CP**

AES provides high spatial resolution anal-
ysis of the surface of the specimen, with a later-
al resolution of 10 to 20 nm and a depth of
approximately 6 nm. This feature makes it
possible to clearly distinguish nanometer-sized
defects and particles in cross-sectional anal-
ysis. However, if impurities adhere to a cross
section, or if any layer covers another layer on
an interface, this phenomenon greatly degrades
the accuracy of the high spatial-resolution,
surface analysis. To prevent this in cross-sectional
Auger analysis, conventionally, a cross section
prepared by mechanical polishing was subject to
a long-time Ar ion sputtering to remove the
impurities from the surface or a distorted layer
due to polishing. But as mentioned in the pre-
vious section, long-time sputtering induces
preferential sputtering, causing surface rough-
ness or changes the chemical composition on
the surface.
CP, developed to overcome these problems,
reduces distortion due to polishing and enables
one to analyze fine structures of an interface,
which was difficult to find from the cross sec-
tion prepared by mechanical polishing.
Furthermore, CP allows a clean cross section
with few impurities. These advantages imply
that CP, as well as FIB, can be utilized as a
powerful sampling tool for Auger analysis. In
this section, various cross sections prepared by
CP are evaluated to discuss whether they are
appropriate for Auger analysis, and the results of
evaluation are summarized.

**Impurities on cross sections milled by CP**

We examined to what extent clean cross
sections can be obtained using Auger analysis.
First, a Si wafer was cleaved without its sur-
face having been resin-coated, and the cleaved
surface was milled by CP. Figure 6 shows
secondary-electron images of the milled cross
section and Fig. 7 shows Auger spectra obtained from six points on it.
In Fig. 7, it is found that C, O and Ar are
detected at all points 1 to 6. The peak intensi-

ties of C and O are very small, suggesting that
C and O are impurities adhering to the wafer
when it was exposed to the air or during its
transfer. These impurities are considered not to
be produced by CP milling. For Ar, it is more
detected from a region where CP milling is going on (points 5 and 6) than where CP
milling has ended (points 1 to 4).
This milled wafer was then subjected to the
time variation examination of impurities
adhering to the cross section for 18 minutes
(Fig. 8). In conclusion, from the Auger spectra
in Fig. 8, it is found that although the wafer
was irradiated with a 10 kV, 40 nA electron
beam, the peak intensity of C does not
crease, and to the contrary, the oxidized Si is
reduced, decreasing the peak intensity of O.
From this result, the cross section of the
cleaved wafer prepared by CP milling is found
to be clean. In addition, the Si LVV peak
shapes at 0 min and 18 min in Fig. 8 were
compared (Fig. 9). It is found that the reduc-
tion reaction due to the electron-beam irradia-
tion altered an oxide peak to a metal peak.
Using the fact that the intensity of the Si LVV
peak at 0 min is half that of the standard Si
spectrum, and utilizing the escape depth of
Auger electrons, we could estimate that the
thickness of the oxide on the cross section
milled by CP is 1 to 2 nm from its surface, and
approximately 50% of Si is oxidized.

A Si wafer, which was resin-coated to
protect its surface, was milled by CP and the
amount of impurities on its cross section was
examined. The epoxy G-2 (supplied by JEOL
DATUM) was used for resin coating. In the
experiment, the surface of the Si wafer was
thiny coated with G-2 resin and hardened.
Following this process, as in the previous
experiment, the Si wafer was cleaved and CP
milling was conducted for the cleaved surface.
Figure 10 shows secondary electron images of
the milled cross section and Fig. 11 Auger
spectra obtained from six points on it.
In Fig. 11, it is found that C, O and Ar are
detected at all points 1 to 6, as in Fig. 7 (with-
out G-2 resin coating). The peak intensities of
C and O are very small, suggesting that C and
O are impurities adhering to the wafer when it
was exposed to the air or during its transfer.
These impurities are considered not to be con-
taminants caused by G-2 resin. For Ar, as well
as in Fig. 7, it is more detected from a region
where CP milling is going on (points 5 and 6)
where CP milling has ended (points 1 to 4).
This milled wafer was then subjected to the
Fig. 6 Cross section of a Si wafer milled by CP without resin coating (irradiation conditions: 10 kV, 40 nA).

Fig. 7 Auger spectra obtained from the cross section milled by CP without resin coating.

Fig. 8 Time variation of Auger spectra for 18 min electron-beam irradiation, obtained from the cross section milled by CP without resin coating (irradiation conditions: 10 kV, 40 nA, spectra acquisition at 2 min-intervals).

Fig. 9 Change of shape of Si LVV peaks caused by the reduction reaction due to the electron-beam irradiation (at 0 min and 18 min).

Fig. 10 Cross section of a Si wafer milled by CP with G-2 resin coating (irradiation conditions: 10 kV, 40 nA).

Fig. 11 Auger spectra obtained from the cross section milled by CP with G-2 resin coating.

Fig. 12 Time variation of Auger spectra for 18 min electron-beam irradiation, obtained from the cross section milled by CP with G-2 resin coating (irradiation conditions: 10 kV, 40 nA, spectra acquisition at 2 min-intervals).
time variation examination of impurities adhering to the cross section for 18 minutes (Fig. 12). As in the previous experiment, from the Auger spectra in Fig. 12, it is found that although the wafer was irradiated with a 10 kV, 40 nA electron beam, the peak intensity of C does not increase, and to the contrary, the oxidized Si is reduced, decreasing the peak intensity of O. From this result, it is found that although G-2 resin was used to protect the surface, it generated impurities and the use of the resin is suitable in samples for Auger analysis.

Differences of cross sections milled by CP with and without resin coating

In the last section, we demonstrated that even when G-2 resin coating is applied to the surface of the specimen, a clean cross section is prepared by CP milling without impurities adhering to its surface, causing almost no problem for Auger analysis. However, in Auger analysis, it is necessary to eliminate the possibility of contaminating the surface as much as possible, and to pursue the analysis of the specimen surface with its native state preserved. Two specimens with and without G-2 resin coating were prepared, and they were milled by CP, then subjected to Auger analysis.

Fig. 13 compares SEM images of cross sectional specimens of an IC having an unevenness of approximately 1 μm, with and without G-2 resin coating. It is found that fine structures can be observed for both specimens at a magnification of ×100,000, implying that clean cross sections were prepared from both specimens. However, on the cross section without G-2 resin coating, vertical streaks left by the beam due to the unevenness of the top surface remain. In addition, when the top surfaces of the two specimens are viewed from the direction of the cross section, it is found that for the specimen without G-2 resin coating, CP milling somewhat altered the morphology of its top surface; to the contrary, for the specimen with G-2 resin coating, its top surface is protected with the morphology preserved.

Next, Fig. 14 compares Auger spectra of the two specimens. The Auger spectra were obtained from seven to eight points. Almost no difference is seen at points 2 to 7 on both specimens; however, at point 1 on the Si₃N₄ layer of the top surface, the detected elements are greatly different. This is due to the fact that when CP milling is conducted without resin coating, since there is a gap between the shielding plate and the specimen, Ni and P that are the constituent elements of the shielding plate are implanted in the layer of the top surface, induced by Ar etching by CP. It is concluded that when preparing cross sections by CP milling without resin coating, Ar etching influences the top surface and may change its morphology and chemical composition; therefore, care should be exercised.
Problem of charging of resin on the specimen

The effect of charging when G-2 resin is used is discussed. Since AES analyzes the top surface of the specimen, even when a specimen that causes charging is used, it cannot be coated with a conductive thin film, unlike in the analysis using SEM-EDS or EPMA. Thus, when the specimen contains an insulating material, this portion is covered with an aluminum foil or indium sheet so that it is not irradiated with the electron beam as much as possible. However, when CP milling is applied, since the top surface of the specimen is frequently resin-coated before cross-section preparation by CP, whether G-2 resin is charged or not is a crucial problem that influences the results of Auger analysis.

In principle, G-2 resin becomes charged because it is insulating material. In fact, various factors, such as the state and chemical composition of the specimen, and the thickness and the extent of adhesion of resin coating, seem to determine whether the resin is charged or not. For example, in Fig. 14(a), the Auger spectrum obtained from point 8 (on G-2 resin) is not disturbed by resin coating, revealing the constituent elements to be C, N, and O. On the other hand, in Fig. 10, the secondary-electron image of the Si wafer elucidates that the same G-2 resin was charged greatly. Thus, depending on the specimen, G-2 resin is sometimes charged and sometimes not. The reason for it is not known. In actual experiments, even when the G-2 resin part on the specimen surface is charged, a charge-neutralizing gun irradiates the surface with Ar ions, suppressing the effect of charging. Thus, Auger analysis can be performed regardless of specimen charging.

Differences of cross sections prepared by FIB and by CP

Conventionally, when a specimen has a fine structure 1 μm or less in size, FIB was used to prepare a cross section containing this structure before Auger analysis. CP which was developed by JEOL can preserve a clean, fine cross-sectional structure. We considered differences of cross sections prepared by FIB and by CP for Auger analysis.

First, the differences are considered in terms of SEM image. Figure 15 shows SEM images of a cross section of an IC prepared by FIB (specimen: IC, irradiation conditions: 10 kV, 24 pA). These images were taken with the same magnification (×115400) as that in Figs. 13 and 14; however, the SEM images in Figs. 13 and 14 are slightly different due to the cross section tilt in SEM vs. FIB. From these images, it is found that both FIB and CP can prepare high-quality cross sections, which provide good sharpness and contrast in SEM images.

Next, the differences of two cross sections prepared by FIB and by CP are considered in terms of Auger spectrum. Figure 16 compares three Auger spectra of Si parts on cross sections milled by FIB and CP (specimen: IC, irradiation conditions: 10 kV, 10 nA).
spectra were obtained from the Si parts of both cross sections, immediately after FIB and CP milling. The bottom spectrum is the standard Si spectrum. Ga was detected from the cross section milled by FIB and Ar by CP. Both elements seem to be mixed into the cross sections during the etching. The other detected elements, C, O and Si are the same for the two cross sections. However, the peak intensities of C and O obtained from the FIB-milled cross section are higher than those from the CP-milled section. In addition, the Si spectrum from the FIB-milled section has a shape of combined spectra of pure Si and oxidized Si. These facts indicate that when FIB is used to prepare a cross section, carbon impurities are easier to adhere to the cross section and it is more susceptible to oxidization than when CP is used.

C and O adhered to both cross sections prepared by FIB and by CP when the cross sections were exposed to the air for approximately five minutes during their transfer. The adsorption speed and reaction speed of C and O are slower on the CP-milled section than on the FIB-milled section. The difference of the speeds may be due to the presence of altered layers or Ga inclusions, but a clear reason is not known. Study will have to be conducted in the near future. In actual Auger experiments, however, the cross section is subjected to surface cleaning with Ar ions before FIB or CP milling. Thus, Auger analysis can be performed on such samples without introducing artifacts.

As mentioned above, we found that high-quality cross sections for Auger analysis can be prepared by both FIB and CP. FIB prepares a cross section with an accuracy of a few tens of nanometers while controlling a region a few tens of micrometers in width. On the other hand, since CP uses an optical microscope to align the target portion to be prepared, it mills a region a few hundreds of micrometers in width, with an accuracy of approximately 10 micrometers. Thus, the accuracies of the portions milled by FIB and CP are significantly different. We may conclude that, for Auger analysis, the appropriate tool for cross-section preparation depends on the state or the size of the target specimen.

Application Examples of Auger Analysis of Cross Sections Prepared by CP

We demonstrated that CP is very useful for Auger analysis of cross sections. In this section, two application examples of Auger analysis of cross sections prepared by CP are presented.

Auger analysis of a cross section containing insulating material (a wire junction in an IC part)

In an Auger experiment of a cross-sectional specimen containing insulating material, a
cross section was prepared from a molded IC part that controls a liquid-crystal display of a cellular phone. **Figure 17** shows the photograph of the IC part of the same type used for the experiment and the schematic diagram of the portion of the cross section prepared by CP (together with a secondary-electron image of an IC cross section). CP can prepare the cross section with the native state of the molded IC preserved while not peeling off the molded resin. In this experiment, an interface between the Si substrate and an Au electrode was subjected to cross-sectional Auger analysis.

**Figure 18** shows the result of Auger analysis. It is found that high-intensity W and Ti are detected from a defect part, whereas Al is detected at a central black point (point 4) in the defect part. **Figure 19** shows the result of Auger mapping of the defect part for C, Al, Ti, W and Au, respectively. This mapping was conducted over the field of view with a magnification of ×50,000. Although the black point is very small, approximately 100 nm in size, high spatial resolution provided by Auger analysis enables micro-defects to be clearly distinguished.

**Cross-sectional Auger analysis of a bonded interface of soft material (a bonded interface of Sn and Cu)**

In an Auger experiment of a bonded interface of soft materials, the bonded interface of Sn and Cu was subjected to cross-sectional Auger analysis. It is known that on this interface, two thin layers of different atomic concentrations, which are Cu:Sn = 3:1 and 6:5, respectively, are formed. If the quality of the prepared cross section is low, it is difficult to observe the fine structures of these layers. To prepare a high-quality cross section, CP milling was conducted for the layers and they were subjected to cross-sectional Auger analysis.

The procedure of this Auger analysis is as follows: Sn was placed on a heated Cu substrate and Sn reacted with Cu, then natural cooling was applied to this specimen. After the specimen was cooled, it was subjected to CP milling for cross-section preparation. Ar ion sputtering was performed for the prepared cross section in an ultrahigh vacuum. Then, C and O were removed from this section to make its surface clean. Finally, Auger analysis was conducted for it.

**Figure 20** shows SEM images of the bonded interface of Cu and Sn. It is found that, from the bottom to the top of the specimen, four different layers are formed in the following order: a Cu layer, a layer of Cu:Sn = 3:1, a layer of Cu:Sn = 6:5, and a Sn layer. However, another layer appears to form on the interface between the layer of Cu:Sn = 6:5 and the Sn layer. For more study, Auger spectra were obtained from this interface. The result of the Auger measurement is shown in **Fig. 21**.

When the Auger spectra of points 2 and 3 are compared, the peak intensity of Cu at point 3 is higher than that at point 2, whereas the intensity of Sn is lower at point 3 than at point 2. To understand this phenomenon, Auger mapping was conducted for Cu and Sn. This result is shown in **Fig. 22**. The Auger maps indicate that another layer exists between the layer of Cu:Sn = 6:5 and the Sn layer.

**Conclusion**

Since Auger analysis provides a high resolution and can analyze nanometer-level regions from the top surface to a depth of 6 nm, it is applied to fine structure analysis of cross sections, as well as to top surface analysis. The method of preparing cross sections is very important because the results of cross-sectional Auger analysis depend greatly on the quality of the prepared cross sections. Using the Cross Section Polisher (CP) developed by JEOL, we evaluated whether cross sections prepared by the CP can be used for Auger analysis.

The following results were found: a) CP can prepare high-quality cross sections that preserve fine structures, as FIB can, b) The surface of the cross section prepared by CP is sufficiently clean for Auger analysis, c) This clean cross section can be prepared over a wide region of a few hundreds of micrometers in width.

This powerful cross-section preparation tool, CP, will be applied to various analytical fields, as it complements the size of the cross sections prepared by conventional mechanical polishing and by FIB (The cross sections prepared by CP are smaller than those prepared with mechanical polishing and wider than with FIB).

**References**


Introduction

The Scanning Probe Microscope (SPM), including the Atomic Force Microscope (AFM) and the Scanning Tunneling Microscope (STM), is widely used as a powerful tool to measure a topographic shape of a sample with nanometer-scale resolution. Recently, applications of the SPM to study material properties have been increasing. The reason for this is that in addition to the original topographic-measurement capability, the SPM has provided increasingly versatile capabilities, such as visco-elasticity atomic-force microscopy (VE-AFM), lateral-modulation friction force microscopy (LM-FFM) and scanning Kelvin probe microscopy (SKPM), which enable one to obtain mechanical or electrical properties of the sample with its topography.

Most of the modern SPM instruments are used at ordinary temperatures and pressures. There are, however, strong demands to use SPM in actual environments, such as at low or high temperatures, in controlled atmospheres and in vacuum, in which observed samples are practically used as industrial products. This situation has necessitated the development of a SPM in which sample environments can flexibly be controlled.

To satisfy the demand, JEOL has developed a new environmental SPM: the JSPM-5400. This innovative SPM is aimed at achieving multi-functional measurements and flexible sample environment control as well as providing high-resolution imaging.

Features of JSPM-5400

Figure 1 shows the external appearance of the JSPM-5400. The JSPM-5400 has been developed on the basis of the following three main concepts.

High-resolution imaging without damage using Non-contact AFM (NC-AFM)

Usually, the AFM has been used with amplitude detection. As for this detection method, the cantilever is scanned with intermittent contact on the sample surface. Therefore, there is always a possibility for the cantilever to damage it, especially when the soft sample is measured.

JEOL SPMs are equipped with a Non-contact AFM (NC-AFM) that employs a constant excitation amplitude FM (frequency modulation) detection method. The main feature of the NC-AFM is to provide a high-resolution topographic image without contact between the apex of the cantilever and the sample surface. The sensitivity of this FM detection has further been improved due to the employment of a digital PLL (Phase-Locked Loop) for a new amplifier, which enables high-stability imaging with atomic-level resolution. This robust capability is demonstrated in a topographic image of mica obtained with the NC-AFM (Fig.2). Because an auto gain control (AGC) circuit is incorporated in the new amplifier with a constant amplitude mode, the JSPM-5400 enables us to observe a dissipation image of a sample, which displays energy dissipation in the sample.

Environmental control for versatile imaging

To achieve versatile imaging under diverse sample environments controlled by the JSPM-5400, drastic improvements of capabilities and extension of optional accessories have been made.

Flexible environmental control

The vacuum quality has increased due to the...
improvement of the structure of the SPM head and the employment of an optional cold trap system. By the use of the cold trap system, the vacuum pressure around the sample reaches down to $8.5 \times 10^{-6}$ Pa, when the pressure is approximately $2.0 \times 10^{-5}$ Pa with ordinary pumping. Thus, gas adsorption on the sample can be reduced to a minimum, maintaining a clean sample surface. Because optical-axis alignments of the laser and photo detector are designed to be performed from the outside of the vacuum, the JSPM-5400 provides optimal imaging for any cantilever.

● Extension of optional accessories

The JSPM-5400 can be equipped with extended optional accessories for multi-purpose, multi-functional measurements, including heating/cooling holders, a temperature controller for stable observation of heated/cooled samples and an airlock sample exchanger that enables a sample to be changed while maintaining the vacuum.

New technologies for safety and easy operation

The JSPM-5400 has served extended new functions, such as shortening measurement and approach time, and preventing collision between the sample and the cantilever.

● Safety high-speed approach

In a conventional SPM, the cantilever approaches the sample at a constant speed and stops at a specified position (Fig. 4(b)). Thus, when the distance between the cantilever and the sample is far, approaching requires a long time.

To shorten the approach time, the JSPM-5400 uses a two-step, safety high-speed approach: high-speed approach and fine approach (Fig. 4(a)). The former detects weak attractive force from a far field, whereas the latter detects the distance between the cantilever and the sample while finely controlling the sample position; therefore, the cantilever can approach the sample in a shorter time. Figure 5 shows a comparison of the approach time with the conventional constant-speed approach and with that with the safety high-speed approach, indicating that the safety high-speed approach significantly reduces the approach time, which is crucial for many applications requiring rapid analysis.
speed approach shortens the approach time by about one sixth compared to the conventional constant-speed approach. The safety high-speed approach is effective for highly light scattering samples and transparent samples, which are difficult to know the actual distance between their surfaces and the cantilever.

● Damage-less scan control

Damage-less scan control is used to operate the probe within a limited area (distance L in Fig. 6) with respect to a reference height (point A in Fig. 6). In the observation of the edge of cross sections, which is difficult for the conventional SPM, the probe can be safely scanned without collision of the apex of the cantilever with the edge. In addition, the damage-less scan control incorporates a reference-height automatic renewing function. This function automatically renews the reference height in the upper direction of a concave portion even for a sample with steep concavity (patent applied for). Thus, the JSPM-5400 can measure samples with unknown topographic shapes, without damage.

Figure 7 shows a topographic image of a multi-layer optical film using the damage-less scan control. The layer structures of the multi-layer optical film can be observed successfully even around the edge.

● Fast and simple positioning

A sample of a polymer mixture tends to have components with different diameters, causing steep unevenness of the surface of the sample. This may lead to the situation that the cantilever collides with the sample surface and fast observation to obtain its entire image is difficult.

Combined use of the skip-scan function and damage-less scan control incorporated in the JSPM-5400 enables us to rapidly observe the entire image of the sample having an unknown topographic shape, without the collision between the cantilever and the sample. Figure 8 shows a topographic images of glue made of a polymer mixture, obtained by a combination of the skip-scan and the damage-less scan control. In addition, use of a zoom function for the field of interest, which allows us to arbitrarily specify the ratio of horizontal and vertical sizes and rotations, can dramatically shorten useless scan time.

● Probe auto tracking

This function automatically corrects the vertical drift caused by thermal expansion or contraction of the sample during observation with heating or cooling, preventing the apex of the probe from crushing or getting away from the sample surface over a long period of time. Figure 9 shows images of a polyester-based compound resinous film, sequentially obtained using probe auto tracking. Topographic and phase images were acquired through temperature variations where the sample was heated in steps of 1°C per minute.

No change is seen in the topographic image, but significant changes are detected in the phase images of the surface. The phase images reveal the change of the sample state, which becomes uniform by heating.

● Digital zoom

Up to 2048×2048 pixels are provided for images, allowing images to be simultaneously displayed for up to 5 channels. Figure 10 shows phase images of a two-component wax mixture, which are displayed with maximum pixels. Since the phase image contains information on physical properties of materials, it is frequently utilized simultaneously with the topographic image. From images acquired with maximum pixels, we can easily pick up enlarged images on areas of interest in digital zoom.

Summary

This paper has introduced the JSPM-5400, which achieves flexible environmental control, high-resolution imaging and ease of use. This versatile environmental SPM is especially suited for high-resolution observations of polymer samples, which will give deeper insights for various fields including the development of new products.
Fig. 9  Topographic images (upper) and phase images (lower) of a polyester-based compound resinous film through temperature variations (scan size: 2 μm × 2 μm).

Fig. 10  Phase images of a two-component wax mixture.
**Introduction of New Products**

**Field Emission Electron Microscope**

**J E M -3100F**

For evaluation of materials in the fields of nanoscience and nanomaterials science, TEM is required to provide resolution and analytical capabilities that can directly distinguish atoms. The JEM-3100F, a superb analytical TEM, can achieve sub-nanometer resolution for structural and compositional analyses. Its sophisticated electron optical system allows a clear image with 0.1 nm resolution to be obtained. In addition, its improved mechanical and electrical stability provides a stable electron beam for a 0.14 nm probe. These features make the JEM-3100F a suitable tool for analyzing materials at the atomic and molecular level.

**Main performance (in UHR configuration)**

- Accelerating voltage: Up to 300 kV
- Electron gun: ZrO/W (100) Schottky emitter
- TEM resolution: 0.17 nm
- STEM resolution: 0.14 nm
- Probe current: 0.5 nA at 1 nm-probe
- Specimen tilt angle: ±25°

**Information limit**

Young fringe pattern taken from a TEM image of an amorphous Ge foil with Au particles. The circle indicates a 0.1 nm resolution line. This pattern verifies an information limit better than 0.1 nm.

**High-resolution STEM-HAADF image**

STEM-HAADF image of a Si [110] single crystal. An atomic spacing of for the (400) plane of Si is clearly resolved, together with a FFT pattern containing a spot corresponding to an atomic spacing of 0.111 nm. This indicates that a probe diameter less than 0.111 nm can be obtained with the JEM-3100F.
Introduction of New Products

Electron Microscope

**JEM-1400**

The JEM-1400 is a 120 kV TEM that provides outstanding results for beginners and experts alike.

**Electron optical system for high contrast**
An electron optical system that provides high-contrast TEM images is essential in all medical and biological investigations. The JEM-1400 incorporates newly designed objective lenses for high-contrast, high-resolution imaging.

**Computer-controlled high-performance goniometer stage**
The JEM-1400 features a high-performance, side-entry goniometer stage with 5-axis computer-control (X, Y, Z, and Tilt X and Tilt Y). A new piezoelectric drive system provides the ultimate in accuracy and performance. This stage automatically sets the minimum stage movement steps for each magnification. In addition, the eucentric stage has a high-tilt capability, optimized for tomography.

**Digital CCD camera**
The JEM-1400 is designed on the concept, “unity of camera and column”. A newly developed special-purpose digital CCD camera, optimized for the JEM-1400, is integrated through the TEM Center GUI. Images acquired with this CCD camera are directly stored in digital format.

**Efficient operation environment utilizing advanced techniques (TEM Center)**
The TEM Center framework, developed for an efficient operation environment for the JEM-1400, fully utilizes advanced Windows techniques. Digital-camera TEM images appear in the TEM Center GUI screens. The screens for routine operations are compactly arranged, enabling beginners to use the software easily. Furthermore, expert operators can use sophisticated GUI screens that facilitate direct control of the main elements of the TEM, such as lenses and deflector coils.

**TEM Navigation system Jenie**
The JEM-1400 incorporates a TEM Navigation System, Jenie (JEOL Electron microscope Navigation Interactive Engine). The operator can learn the procedure for operating the instrument while viewing easy-to-understand videos. Jenie offers special operating procedures for tasks such as axis alignment after replacing the electron-gun filament, as well as for routine operation. Thus, Jenie is useful for not only beginners but also administrators. In addition, Jenie enables the operator to add and edit procedures, making it possible to customize a navigation file for each user, as an education program or a routine data collection sequence.

**A unified GUI, a wealth of optional accessories**
The control system of the JEM-1400 is the same as those of JEOL’s performance-winning 200 kV TEMs: JEM-2100, JEM-2100F, JEM-2200FS. A wealth of optional accessories, including STEM, an EDS system, TEM Tomography software, cryo-blades and a variety of specimen holders, are available.
The JSM-7500F is an ultra high resolution FE SEM, which has been developed to satisfy the most demanding researchers in nano technology and related research fields. The SEM is equipped with the high brightness conical FE gun and the low aberration conical semi in-lens objective lens. The improved overall stability of the JSM-7500F enables you to readily observe your specimen at magnifications up to 1,000,000x with the guaranteed resolution of 1 nm at 15 kV. The guaranteed resolution at 1 kV is 1.4 nm. The extremely low electron energy of as low as 0.1 keV can be utilized to reveal fine surface structures of a specimen. The specimen chamber is large enough to accommodate a 200 mm diameter specimen. The unique one action specimen exchange airlock chamber lets you introduce a specimen quickly without breaking the high vacuum in the specimen chamber. The specimen stage has all five axes motorized and controlled by the PC for comfortable and efficient operation. The specimen stage is pumped by the TMP with the magnetic bearing in order to keep the clean environment in the specimen chamber. The JSM-7500FA is the ultra high resolution analytical FE SEM with the JEOL EDS embedded. The operation GUI has the buttons to change the operation mode quickly from the observation mode to the elemental analysis mode. The JSM-7500FA allows a quick start of elemental analysis on the SEM image showing fine surface structures. The user-friendly operation GUI displays the SEM image and the elemental analysis results on the same monitor. The specimen chamber is provided with many accessory ports to accept a variety of detectors including the EBSD for crystal orientation analysis.

The JSM-6701F is the ultra high resolution FE SEM suitable for observation of fine structures such as multi-layered structures and nano particles. The SEM has the guaranteed resolution of 1 nm at 15 kV and 2.2 nm at 1 kV. The lower electron energies are effective in observation of fine surface structures. The electron optics is completely automated so that the electron energy and the probe current can be changed and the observation condition can be optimized quickly to suit for a variety of specimens. The specimen chamber is large enough to accommodate a 200 mm diameter specimen. The unique one action specimen exchange airlock chamber lets you introduce a specimen quickly. The specimen stage has X, Y, and rotation axes motorized and controlled by the PC for comfortable and efficient operation. The unique aperture angle optimizing lens lets you use the maximum probe current of 2 nA even at a very high magnification. The higher probe current is effective for the elemental analysis with the optional EDS.
Introduction of New Products

High-Performance General-Purpose SEM with a large specimen chamber
JSM-6490 series

The JSM-6490 series SEM is a flexible multi-purpose SEM. Multiple users can customize the operation GUI for efficient operations with optimum performance. The well-accepted user-friendly GUI has been upgraded to be more compatible with the multiple user environment. A unique addition is SmileShot, which sets the SEM for the optimum conditions by simply selecting the conditions of a specimen. In addition, JEOL has added new features: multiple live image display, signal mixing, full-screen live image and movies (AVI files).

The large specimen chamber and the five-axis motor controlled specimen stage with large movements can readily handle a large variety of specimens. The JSM-6490LV, which has a low vacuum mode built-in, can observe and analyze non-conductive specimens without any conductive coating.

The JSM-6490A and JSM-6490LA are the analytical scanning electron microscopes with a JEOL EDS elemental analyzer embedded. These compact SEM systems offer comfortable seamless operation from observation to elemental analysis.

- Resolution: 3.0 nm (HV mode), 4.0 nm (LV mode)
- Accelerating voltage: 0.3 to 30 kV (56 steps)
- Magnification: ×5 to 300,000
- Specimen size: Up to 203 mm diameter
- Specimen stage: X=125 mm, Y=100 mm, Z=5 to 80 mm
  T=–10 to 90°, R=360°

High-Performance General-Purpose SEM
JSM-6390 series

The JSM-6390 series SEM is a user-friendly high-performance general-purpose scanning electron microscope composed of the fully automated high-performance electron optics and the newly developed multi-user compatible operation software with the new features, live image display, signal mixing, full-screen live image and movies (AVI files). The JSM-6390LV, which has the low vacuum mode built-in, can observe and analyze non-conductive specimens without any conductive coating. The JSM-6390A and JSM-6390LA are the analytical scanning electron microscopes with a JEOL EDS elemental analyzer embedded. These compact SEM systems offer comfortable seamless operation from observation to elemental analysis.

- Resolution: 3.0 nm (HV mode), 4.0 nm (LV mode)
- Accelerating voltage: 0.5 to 30 kV (53 steps)
- Magnification: ×5 to 300,000
- Specimen size: Up to 150 mm diameter
- Specimen stage: X=80 mm, Y=40 mm, Z=5 to 80 mm
  T=–10 to 90°, R=360°
Introduction of New Products

High-Performance Single-Beam FIB
with a large ion-beam current

JEM-9320FIB

The JEM-9320FIB is the latest high-performance single-beam FIB with the high-speed milling, high resolution, and high beam current in a simple, compact design. This FIB can prepare thin-film from local areas of STEM/TEM specimens and achieves precise, fast milling for SEM cross section specimens.

**High-speed, high-precision milling, high-resolution observation**

High-speed milling with a large ion-beam current (at 30 kV, 30 nA or larger) reduces the rough-milling time significantly.

The improved ion optical system enables one to observe a high-resolution SIM image (6 nm, 30 kV).

**Space-saving, energy-saving**

The JEM-9320FIB can be installed even in a space smaller than 3 m × 3 m because of its small footprint.

The JEM-9320FIB has an energy-saving (beam-saver) mode to reduce power consumption.

**Twin stage**

The JEM-9320FIB can be equipped with a side-entry goniometer stage and a bulk specimen eucentric stage at same time or with just one stage to meet to your applications.

**Improved GUI**

The JEM-9320FIB has an improved graphical user interface with new functions for easy operation and stable processing.

**Automatic processing software (optional)**

Automatic processing software enables one to preprocess STEM/TEM specimens and SEM cross section specimens automatically.

This software continuously processes multiple points while automatically correcting the beam positions. Its recipe allows automatic processing up to 300 points with a maximum processing width of 100 µm.

- **Ion source** Ga liquid metal ion source
- **Accelerating voltage** 5 to 30 kV (in 5 kV steps)
- **Magnification** × 50 (field search), × 150 to 300,000
- **Image resolution** 6 nm (at 30 kV)
- **Maximum beam current** 30 nA (at 30 kV)
- **Specimen size** 28 mm diameter (13 mm thick), 50 mm diameter (2 mm thick)
The JBX-6300FS is a Spot-type Electron Beam Lithography System, which can meet a wide range of needs for research, prototype manufacturing and production, including nano-molecular devices, photonic crystal devices, quantum-effect devices, optical devices, communication devices and MEMS devices.

- A thermal field emission electron gun enables the accelerating voltage to be selected and switched from 100 kV, 50 kV and 25 kV.
- Its electron optical system produces a small probe down to 2 nm in diameter at the maximum accelerating voltage of 100 kV, calculated with optical simulation. In addition, the JBX-6300FS employs a 19 bit DAC for beam positioning that allows high-precision lithography, achieving a minimum line width of 8 nm (at the center of lithography fields).
- The step-and-repeat method is used for stage movement. The stage position is controlled by the measurement of a laser interferometer with a reading accuracy of 0.62 nm. Thus, the JBX-6300FS achieves high field-stitching accuracy and high overlay accuracy.
- A workstation running under a UNIX operating system is used as a calculation system. Combined use of this workstation with GUI (graphical user interface) provides high operability.

### Main Specifications

<table>
<thead>
<tr>
<th>Specification</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Electron gun emitter</td>
<td>ZrO/W TFE</td>
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<tr>
<td>Accelerating voltage</td>
<td>100 / 50 / 25 kV</td>
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<td>Minimum beam diameter</td>
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<td>Scanning type</td>
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<td>Beam-positioning DAC</td>
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<td>Beam-scanning DAC</td>
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<td>Beam-scanning speed</td>
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<td>Laser resolution</td>
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<td>Field size</td>
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<td>Field-stitching accuracy</td>
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<td>Overlay accuracy</td>
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<tr>
<td>Workpiece dimension</td>
<td>Up to 200 mm in diameter</td>
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</tbody>
</table>

[1]: Calculated with optical simulation.

### Examples of Lithography Patterns

- **Line and Space**: Line: 8 nm, Pitch: 40 nm
- **Photonic**: Dot: 30 nm, Pitch: 70 nm